

# SANYO Semiconductors DATA SHEET

# LC89057W-VF4A-E — CMOSIC Digital Audio Interface Transceiver

#### 1. Overview

The LC89057W-VF4A-E is an audio IC that demodulates and modulates signals according to data transfer format between digital audio devices via the IEC60958/61937 and EIAJ CP-1201 and supports up to 192kHz of sampling frequency. It features a built-in VCO and oscillation amplifier, two bit clock circuits that are capable of setting independently the frequency-dividing ratios that can also be used for the DSP data input/output clocks, and LR clock output pins. A multi-channel PCM interface using multiple LC89057W-VF4A-E ICs is also available through a master/slave function.

This IC is optimal for use in high performance AV amplifiers and a multi-channel PCM interface for DVD audio equipment.

#### 2. Features

#### 2.1 Realizes full demodulation for high performance AV equipment

- Possible to receive the sampling frequency of 32kHz to 192kHz and 24 bits data at a maximum.
- Supports I<sup>2</sup>S data output that facilitates interfacing with DSP.
- Output clock: 512fs, 256fs, 128fs, 64fs, 32fs, 2fs, fs, and fs/2
- Possible to output oscillation amplifier and external input clocks regardless of the PLL status.
- Maintains output clock continuity during clock switching.
- Supports Multi-channel transfer and reception, using master/slave function.
- Possible to process demodulation functions using common low-jitter clock without using PLL (external clock synchronization function)
- Built-in PLL error lock prevention circuit to provide accurate lock

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#### 2.2 Outputs various information to make system configuration easy

- Outputs DTS-CD/LD detection flag by DTS sync signal detection.
- Outputs burst preamble Pc from microcontroller interface.
- Calculates sampling frequency of input signal and outputs it from microcontroller interface.
- Outputs interrupt signal for microcontroller (interrupt source can be selected).
- Outputs signal of transitional period switching between VCO clock and oscillation amplifier clock.
- Outputs bit 1 of channel status (non-PCM data detection bit).
- Outputs emphasis information of channel status.
- Outputs renewed flag of the first 48 bits channel status.
- Channel status bit, validity flag and user data output are selectable.
- Outputs modulation/demodulation preamble B information.
- Possible to carry out and output various settings through microcontroller interface.

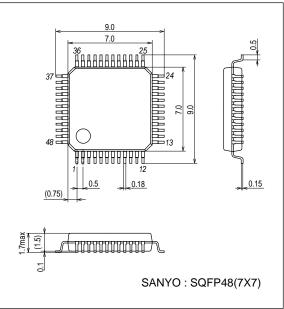
#### 2.3 Plenty of built-in functions to reduce peripheral circuits

- Includes modulation function that can attach channel status, validity flag, and user data.
- Equipped with a total of 7 digital data input pins: 1 input pin with an amplifier and 6 input pins with 5V tolerable TTL level signal.
- Possible to monitor input pin status with microcontroller by mounting a bi-phase input data detection function.
- Possible to select input data among 8 system input data including modulation function output.
- Possible to select output of input-data through among 8 system input data aside from selecting demodulation data.
- Includes 2 system bit clock and LR clock outputs. Various frequency-dividing ratios can be set to one of these two systems.
- Equipped with a serial digital audio data input pin. Possible to switch with demodulation output.
- Possible to modulate the data that is input to the serial digital audio data input pin.
- Includes built-in oscillation amplifier and frequency divider for quartz resonator and also possible to use them as clock generator.
- Includes 4 bits general-purpose parallel I/O port. It can be used for interface with peripheral ICs.
- All the channel status can be decoded through peripheral circuit using preamble B information.
- A continuous switching operation between external clock synchronous mode and PLL clock synchronous mode is possible.
- Single 3.3V-power supply operation. TTL input port supports 5V interface.
- Adopts small SQFP48 package for efficient use of substrate mounting area.

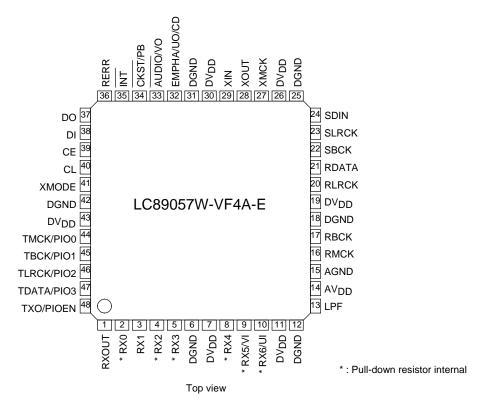
# Package Dimensions

unit : mm (typ)





#### 4. Pin Assignment



# 5. Pin Functions

#### **Table 5.1 Pin Functions** Pin No. I/O Function Name 1 RXOUT 0 Output pin of Input bi-phase selection data RX0 2 $I_5$ Input pin of TTL-compatible digital data 3 RX1 I. Digital data input pin with built-in amplifier that supports coaxial 4 RX2 $I_5$ Input pin of TTL-compatible digital data RX3 5 $I_5$ Input pin of TTL-compatible digital data DGND Digital GND 6 7 DVDD Digital power supply 8 RX4 $I_5$ Input pin of TTL-compatible digital data RX5/VI TTL-compatible digital data || Validity flag input pin for modulation 9 $I_5$ RX6/UI 10 $I_5$ TTL-compatible digital data || User data input pin for modulation 11 DVDD Digital power supply for PLL 12 DGND Digital GND for PLL LPF 0 PLL loop filter connection pin 13 AVDD 14 Analog power supply for PLL 15 AGND Analog GND for PLL RMCK 0 R system clock output pin (256fs, 512fs, XIN, VCO) 16 RBCK 17 O/I R system bit clock input/output pin (64fs) 18 DGND Digital GND 19 DVDD Digital power supply 20 RLRCK O/I R system LR clock input/output pin (fs) RDATA 0 21 Output pin of serial audio data 22 SBCK 0 S system bit clock output pin (32fs, 64fs, 128fs) 0 23 SLRCK S system LR clock output pin (fs/2, fs, 2fs) SDIN Input pin of serial audio data 24 $I_5$

Continued on next page.

# LC89057W-VF4A-E

Pin No.	Name	I/O	Function
25	DGND		Digital GND
26	DVDD		Digital power supply
27	XMCK	0	Oscillation amplifier output pin
28	XOUT	0	Quartz resonator connection output pin
29	XIN	I	Quartz resonator connection, input pin of external supply clock (24.576MHz or 12.288MHz)
30	DVDD		Digital power supply
31	DGND		Digital GND
32	EMPHA/UO/CO	I/O	Emphasis information    U data output    C data output    Chip address setting pin
33	AUDIO/VO	I/O	Non-PCM detection    V flag output    Chip address setting pin
34	CKST/PB	I/O	Output of clock switch transitional period signal    Preamble B output    Demodulation master or slave function switch pin
35	ĪNT	I/O	Interrupt output for Microcontroller (Possible to select an interrupt factor.)    Modulation or general-purpose I/O switch pin
36	RERR	0	PLL clock error, data error flag output
37	DO	0	Microcontroller I/F, read data output pin (3-state)
38	DI	I <sub>5</sub>	Microcontroller I/F, write data input pin
39	CE	I <sub>5</sub>	Microcontroller I/F, chip enable input pin
40	CL	I <sub>5</sub>	Microcontroller I/F, clock input pin
41	XMODE	I <sub>5</sub>	System reset input pin
42	DGND		Digital GND
43	DVDD		Digital power supply
44	TMCK/PIO0	I/O	256fs or 128fs system clock input for modulation    256fs or 512fs system clock input for external clock sync function    General-purpose I/O pin
45	TBCK/PIO1	I/O	64fs bit clock input for modulation    General-purpose I/O pin
46	TLRCK/PIO2	I/O	fs clock input for modulation    General-purpose I/O pin
47	TDATA/PIO3	I/O	serial audio data input for modulation    General-purpose I/O pin
48	TXO/PIOEN	O/I	Modulation data output    General-purpose I/O enable input pin

1) Withstand voltage input/output: I or O = -0.3 to 3.6V,  $I_5 = -0.3$  to 5.5V

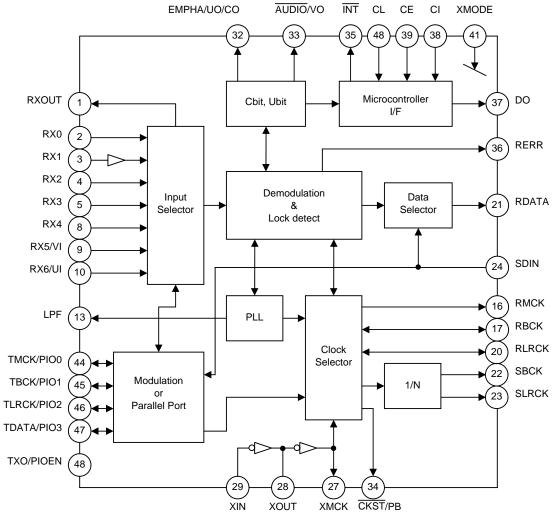
2) Pins 32 and 33 are input pins for chip address setting, when pin 41 = "L".

3) Pin 34 is a demodulation function master or an input pin for slave setting, when pin 41 = "L".

4) Pin 35 is a modulation function or an input pin for general-purpose I/O function switch setting, when pin 41 = "L".

5) ON/OFF for all power supplies must be done at the same timing as a latch-up countermeasure.

#### 6. Block Diagram



## 7. Comparison between LC89057W-VF4 and LC89057W-VF4A Table 7.1 Difference between LC89057W-VF4 and LC89057W-VF4A

Item	LC89057W-VF4	LC89057W-VF4A
DIR function: External synchronization mode	256fs clock input	256fs or 512fs clock input
DIR function: Setting of RERR wait time after PLL	After preamble B is counted 6.	After preamble B is counted 3.
is locked	After preamble B is counted 12.	After preamble B is counted 6.
	After preamble B is counted 24.	After preamble B is counted 12.
	After preamble B is counted 48.	After preamble B is counted 24.
DIR function: Setting of clock wait time after PLL is	50µs from when oscillation amplifier starts	0µs from when oscillation amplifier starts
unlocked	100µs from when oscillation amplifier starts	50µs from when oscillation amplifier starts
	200µs from when oscillation amplifier starts	100µs from when oscillation amplifier starts
	400µs from when oscillation amplifier starts	200µs from when oscillation amplifier starts
DIR function: Channel status bit output	Microcontroller read out	Microcontroller read out or terminal output
		(full decode processing possible)
DIR function: Preamble B info output	×	0
DIT function: System clock	256fs clock input	256fs or 128fs clock input
DIT function: Preamble B info output	×	0

### 8. Electrical Characteristics

#### 8.1 Absolute Maximum Ratings

Table 8.1: Absolute Maximum Ratings at AGND = DGND = 0V

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	AV <sub>DD</sub> max	8-1-1	-0.3 to +4.6	V
Maximum supply voltage	DV <sub>DD</sub> max	8-1-2	-0.3 to +4.6	V
Input voltage 1	V <sub>IN</sub> 1	8-1-3	-0.3 to +3.9	V
Input voltage 2	V <sub>IN</sub> 2	8-1-4	-0.3 to +5.8	V
Output voltage	VOUT	8-1-5	-0.3 to +3.9	V
Storage ambient temperature	Tstg		-55 to +125	°C
Operating ambient temperature	Topr		-30 to +70	°C
Maximum input/output current	IIN, IOUT	8-1-6	±20	mA

8-1-1: AV<sub>DD</sub> pin

8-1-2: DV<sub>DD</sub> pin

8-1-3: RX1, RBCK, RLRCK, XIN, TMCK/PIO0, TBCK/PIO1, TLRCK/PIO2, TDATA/PIO3, TXO/PIOEN pins 8-1-4: RX0, RX2, RX3, RX4, RX5/VI, RX6/UI, SDIN, DI, CE, CL, XMODE pins

8-1-5: RXOUT, RMCK, RBCK, RLRCK, SBCK, SLRCK, RDATA, XMCK, XOUT, EMPHA/UO/CO, AUDIO/VO pins, CKST/PB, INT, RERR, DO, TMCK/PIO0, TBCK/PIO1, TLRCK/PIO2, TDATA/PIO3,

TXO/PIOEN pins

8-1-6: Per input/output pin

#### 8.2 Allowable Operating Ranges

Table 8.2: Allowable Operating Ranges at Ta = -30 to  $70^{\circ}C$ , AGND = DGND = 0V

Deservator	Cumhal	Conditions		Unit		
Parameter	Symbol Conditions		min	typ	max	Unit
Supply voltage	av <sub>DD</sub> , dv <sub>DD</sub>		3.0	3.3	3.6	V
Input voltage range 1	V <sub>IN</sub> 1	8-2-1	0	3.3	3.6	V
Input voltage range 2	V <sub>IN</sub> 2	8-2-2	0	3.3	5.5	V
Operating temperature	Topr		-30		70	°C

8-2-1: RX1, RBCK, RLRCK, XIN, TMCK/PIO0, TBCK/PIO1, TLRCK/PIO2, TDATA/PIO3, TXO/PIOEN pins 8-2-2: RX0, RX2, RX3, RX4, RX5/VI, RX6/UI, SDIN, DI, CE, CL, XMODE pins

#### 8.3 DC Characteristics

Table 8.3: DC Characteristics at Ta = -30 to  $70^{\circ}$ C, AV<sub>DD</sub> = DV<sub>DD</sub> = 3.0 to 3.6V, AGND = DGND = 0V

			,				
Devenuetor	Cumbal	Canditiona		Ratings		Unit	
Parameter	Symbol	Conditions	min	typ	max	Unit	
Input, High	∨ <sub>IH</sub>	8-3-1	0.7V <sub>DD</sub>			V	
Input, Low	VIL				0.2V <sub>DD</sub>	V	
Input, High	VIH	8-3-2	2.0		5.8	V	
Input, Low	VIL		-0.3		0.8	V	
Output, High	VOH	8-3-3	V <sub>DD</sub> -0.8			V	
Output, Low	V <sub>OL</sub>				0.4	V	
Output, High	VOH	8-3-4	V <sub>DD</sub> -0.8			V	
Output, Low	VOL				0.4	V	
Output, High	VOH	8-3-5	V <sub>DD</sub> -0.8			V	
Output, Low	V <sub>OL</sub>				0.4	V	
Output, High	VOH	8-3-6	V <sub>DD</sub> -0.8			V	
Output, Low	V <sub>OL</sub>				0.4	V	
Input amplitude	V <sub>PP</sub>	8-3-7	200			mV	
Consumption current	I <sub>DD</sub> 1	8-3-8		1.7	3.4	mA	
Consumption current	I <sub>DD</sub> 2	8-3-9		17	34	mA	
Consumption current	I <sub>DD</sub> 3	8-3-10		19	38	mA	

8-3-1: CMOS compatible: RBCK, RLRCK, XIN input pins

8-3-2: TTL compatible: Input pins other than those listed above

8-3-3:  $I_{OH} = -12mA$ ,  $I_{OL} = 8mA$ : RMCK output pin

8-3-4: IOH = -8mA, IOL = 8mA: XMCK, XOUT output pins

8-3-5: I<sub>OH</sub> = -4mA, I<sub>OL</sub> = 4mA: RXOUT, RBCK, RLRCK, RDATA, SBCK, SLRCK, TMCK/PIO0, TBCK/PIO1, TLRCK/PIO2 output pins, TDATA/PIO3, TXO/PIOEN output pins

8-3-6:  $I_{OH} = -2mA$ ,  $I_{OL} = 2mA$ : Output pins other than those listed above

8-3-7: Before capacitance of RX1 input pin

8-3-8: Demodulation function and oscillation amplifier stopped, modulation only, output sampling frequency = 96kHz

8-3-9: XIN input continuous 24.576MHz oscillation, demodulation only, input sampling frequency = 96kHz

8-3-10: XIN input continuous 24.576MHz oscillation, modulation, input/output sampling frequency = 96kHz

#### 8.4 AC Characteristics

Table 8.4: AC Characteristics at Ta=-30 to 70°C, AVDD=DVDD=3.0 to 3.6V, AGND=DGND=0V

Demonster	Question	Conditions		Ratings		
Parameter	Symbol	Conditions	min	typ	max	Unit
RX0 to RX6 sampling frequency	<sup>f</sup> RFS		28		195	kHz
XIN clock frequency	f <sub>XF</sub> 1	8-4-1	8	12.288	19	MHz
XIN clock frequency	f <sub>XF</sub> 2	8-4-2	20	24.576	30	MHz
RMCK clock frequency	<sup>f</sup> RCK		4		100	MHz
RMCK clock jitter	tj			200		ps
RMCK, RBCK delay	t <sub>MBO</sub>				10	ns
RBCK, RDATA delay	<sup>t</sup> BDO				10	ns
RMCK, SBCK delay	<sup>t</sup> MBO	8-4-3			10	ns
SBCK, RDATA delay	<sup>t</sup> BDO	8-4-4			10	ns
TMCK input pulse width	<sup>t</sup> WMI		10			ns
RX*, TMCK delay	<sup>t</sup> RDI				1/4TMCK	ns
TBCK input pulse width	<sup>t</sup> WBI		40			ns
TLRCK sampling frequency	<sup>t</sup> TFS		28		195	kHz
TBCK, TDATA setup	<sup>t</sup> DSI			20		ns
TBCK, TDATA hold	<sup>t</sup> DHI			20		ns
TMCK, TBCK delay	t <sub>MBI</sub>	8-4-5			10	ns
TBCK, TDATA delay	<sup>t</sup> BDI				10	ns

8-4-1: XINSEL = 0 setting, 12.288MHz must be set when calculating input sampling frequency

8-4-2: XINSEL =1 setting, 24.576MHz must be set when calculating input sampling frequency

8-4-3: When RMCK and SBCK source clocks are identical

8-4-4: When SBCK is the PLL source clock

8-4-5: TCKSEL = 0 setting (256fs), the falling edge of TBCK is in synchronization with the rising edge of TMCK. TCKSEL = 1 setting (128fs), the falling edge of TBCK is in synchronization with the falling edge of TMCK.

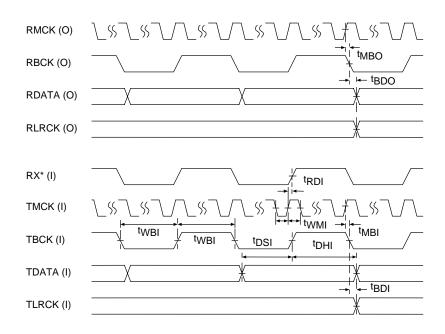


Figure 8.1 AC Characteristics

#### 8.5 Microcontroller Interface AC Characteristics

#### Table 8.5: I/F AC Characteristics at Ta=-30 to 70°C, AVDD=DVDD=3.0 to 3.6V, AGND=DGND=0V

Deremeter	Cumhal	Symbol Conditions	Ratings			Unit
Parameter	Symbol	Conditions	min	typ	max	Unit
XMODE pulse width, Low	<sup>t</sup> RST dw		200			μs
INT pulse width, Low	<sup>t</sup> INT wd	8-5-1	5	1/fs	36	μs
CL pulse width, Low	<sup>t</sup> CL dw		100			ns
CL pulse width, High	<sup>t</sup> CL uw		100			ns
CL, CE setup time	<sup>t</sup> CE setup		50			ns
CL, CE hold time	<sup>t</sup> CE hold		50			ns
CL, DI setup time	<sup>t</sup> DI setup		50			ns
CL, DI hold time	<sup>t</sup> DI hold		50			ns
CL, CE hold time	<sup>t</sup> CL hold		50			ns
CL, DO delay time	<sup>t</sup> CL to DO				20	ns
CE, DO delay time	<sup>t</sup> CE to DO				20	ns

8-5-1: When INTOPF is set to "1", fs = input sampling frequency

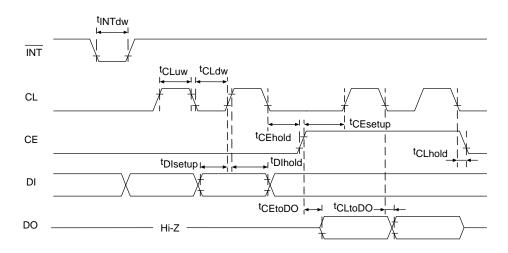


Figure 8.2 Microcontroller Interface AC Characteristics

### 9. Initial System Settings

#### 9.1 System Reset (XMODE)

- The system operates correctly when XMODE is set to "H" after 3.0V or higher supply voltage is applied. When XMODE is set to "L" after power is turned on, the system is reset.
- When setting chip address, demodulation function master or slave, and modulation function or general-purpose I/O function, connect a 10k $\Omega$  pull-down or pull-up resistor to EMPHA/UO/CO, AUDIO/VO, CKST/PB, and INT pins.
- If EMPHA/UO/CO, AUDIO/VO, CKST/PB, and INT are not pulled up or down, their pin state is unstable at the time of input. Consequently proper setting cannot be realized. For these pins, pull-up or pull-down resistor must be connected.

Table 9.1: Pin Names and Settings				
Setting Pins				
Chip address	EMPHA/UO/CO, AUDIO/VO			
Demodulation function master or slave	CKST/PB			
Modulation function or general-purpose I/O function	ĪNT			

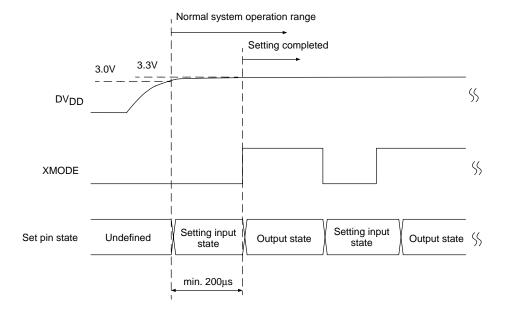


Figure 9.1 Setting Timing Chart of Function Setting Input Pins

#### 9.2 Chip Address Settings (EMPHA/UO/CO, AUDIO/VO)

- The LC89057W-VF4A-E comes with a function to set a unique chip address to allow the use of several LC89057W-VF4A-E on the same microcontroller interface bus.
- In chip address setting, connect a 10k $\Omega$  pull-down or pull-up resistor to EMPHA/UO/CO and  $\overline{\text{AUDIO}}$ /VO. By this setting, 4 kinds of chip addresses can be set at a maximum.
- Chip addresses in the microcontroller interface are set with CAL and CAU provided as the first two bits on the LSB side. CAL corresponds to the lower chip address and CAU to the higher chip address.
- Command writing is enabled by making the chip address settings with EMPHA/UO/CO and AUDIO/VO identical to the chip addresses sent from the microcontroller.
- The chip address setting is required even when only one LC89057W-VF4A-E is used in the system. If the chip address is not set, the chip address is undefined and the microcontroller cannot control the system. When the microcontroller is not used, a chip address-setting pin is input open while XMODE is "L". Be sure to connect either a pull-down resistor or a pull-up resistor to EMPHA/UO/CO and AUDIO/VO.

AUDIO/VO	EMPHA/UO/CO	CAU	CAL
Pull-down	Pull-down	0	0
Pull-down	Pull-up	0	1
Pull-up	Pull-down	1	0
Pull-up	Pull-up	1	1

Table 9.2 Chip Address Settings (Register Connection)

LC89057W-VF4A-E pull-up 10kΩ EMPHA/UO/CO Connect to **AUDIO/VO** different circuits **CKST/PB** INT pull-down 10kΩ ≶ Setting Contents of Above Figure Chip address setting CAIL=CAU=0 Demodulation function master Master or slave setting Modulation function or → General-purpose I/O function General-purpose I/O port switch

Figure 9.2 Setting Example of Function Setting Input Pin

#### 9.3 Demodulation Function Master/Slave Settings (CKST/PB)

- A master/slave function that allows multi-channel synchronized transfer using multiple LC89057W-VF4A-E ICs is included. For this setting, connects either a  $10k\Omega$  pull-down or a pull-up resistor to  $\overline{\text{CKST}}/\text{PB}$ .
- Set to the master mode normally, when single LC89057W-VF4A-E IC is used. When multiple LC89057W-VF4A-E ICs are used, set one of them to the master mode and the others to the slave mode.
- In the multi-channel synchronous transfer mode using multiple LC89057W-VF4A-E ICs, connect RBCK and RLRCK (output) on the master side to RBCK and RLRCK (input) on the slave side. Also connect XMCK on the master side to XIN on the slave side. At this time, the polarity of RBCK and RLRCK, and the frequency of XIN and XMCK must be identical.
- If the input data sampling frequency or the phase are different between the master mode and slave mode or if the clock sources differ while the sampling frequencies are not different, some of the output data may get dropped or read twice on the slave side. You can see if these are happening by INT and the microcontroller interface.

Table 9.3 Master/Slave Switching (Register Connection)					
CKST/PB	Mode				

CKST/PB	Mode
Pull-down	Master
Pull-up	Slave

Table 9.4 Clock Thi State					
Pin	Master mode	Slave mode			
RMCK	Output	Output			
RBCK	Output	Input			
RLRCK	Output	Input			

#### Table 9.4 Clock Pin State

#### 9.4 Switching between Modulation Function and General-Purpose I/O Port (INT)

- The modulation function and the general-purpose I/O function share same pins. Therefore, these two functions cannot be used simultaneously.
- To switch functions, connect either a  $10k\Omega$  pull-down or pull-up resistor to  $\overline{INT}$  pin.

Table 9.5 Switching between Modulation Function and General-Purpose I/O Port (Register Connection)

INT State	Function		
Pull-down	Modulation function		
Pull-up	General-purpose I/O		

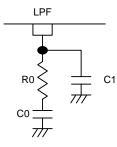
#### **10 Description of Demodulation Function**

• The demodulation function is set with RXOPR. An initial value is set to an operating status.

#### 10.1 Clocks

#### 10.1.1 PLL (LPF)

- The LC89057W-VF4A-E incorporates a VCO (Voltage Controlled Oscillator) that can be stopped with PLLOPR and it synchronizes with sampling frequencies from 32kHz to 192kHz and with the data with transfer rate from 4MHz to 25MHz.
- The PLL lock frequency is selected with PLLSEL. For systems whose input data sampling frequency is 105kHz or lower, the initial setting of 512fs is recommended. Since the initial output value of the system clock RMCK is set to 1/2 of PLLSEL, the RMCK output is 256fs when a PLL clock frequency is 512fs.
- For reception systems whose sampling frequency is higher than 105kHz, switch the PLL clock frequency to 256fs. If the same initial output setting is applied, RMCK is 128fs. Then set with PRSEL[1:0] when necessary.
- When the PLL lock frequency is selected with PLLSEL after PLL is locked, unlock is generated. Accordingly, PLLSEL must be set prior to bi-phase data input.
- LPF is a pin for PLL loop filter. Connect the following resistance and capacitances regardless of PLLSEL settings.



Clock	R0	C0	C1	
512fs	2200		0.000 F	
256fs	220Ω	0.1µF	0.022µF	

Figure 10.1 Loop Filter Configuration

#### 10.1.2 Demodulation function without using PLL (TMCK)

- The LC89057W-VF4A-E has a function that processes input bi-phase data using an external clock (external clock synchronization function). In normal demodulation processing, the built-in PLL generates a clock that is synchronized with data and carries out data processing with the clock. In the LC89057W-VF4A-E, data processing can be also done by providing a clock synchronized with data instead of the PLL-generated clock via an independent transmission path.
- To use the external clock synchronization function, set the PLL unused demodulation function with EXSYNC, set the 256fs or 512fs clock with PLLSEL, and set 1/1 of PLLSEL set frequency with PRSEL[1:0]. After that input the clock synchronized with input data to TMCK. By this settings, the same operation as PLL demodulation processing is performed. For example, 512fs clock should be supplied with TMCK because the setting of PLLSEL is at 512fs in case EXSYNC is set on initial condition. In the event of switching the setting of TMCK clock frequency to 256fs, the setting of PLLSEL should be at 256fs.
- Jitter of input data and clock should be as small as possible. Excessive jitter might invite errors in operation of PLL. Pay attention to the noise of clock transmission path.
- In the external synchronization mode, supply clock with TMCK all the time. Without input of clock, system will shut down and be in malfunction.
- In case of using external clock synchronization mode only, it is not necessary to connect anything to LPF pin. However, configuring PLL loop filter enables to use both PLL clock synchronization mode and external clock synchronization mode by switching EXSYNC.
- Applying the external clock synchronization function can also configure a high-precision clock system using an external PLL.

#### 10.1.3 Oscillation amplifiers (XIN, XOUT, XMCK)

- The LC89057W-VF4A-E features a built-in oscillation amplifier. Connecting a quartz resonator, feedback resistor, and load capacitance to XIN and XOUT can configure an oscillation circuit. When connecting a quartz resonator, use one with a fundamental wave. Be aware that the load capacitance depends on the quartz resonator characteristics.
- If the built-in oscillation amplifier is not used and oscillation module is used as the clock source instead, connect the output of an external clock supply source to XIN. At this time, it is not necessary to connect a feedback resistor between XIN and XOUT.
- Supply XIN with the 12.288MHz or 24.576MHz-clock set with XINSEL. If inputting other frequencies to XIN, it is necessary to set that the result of change in sampling frequency fs of input data is not reflected to an error flag. By this setting, the operation functions properly. However, since time definition gap occurs in relation to the operation with recommended frequency, the encoding result cannot be used for input fs calculations. In this case, the input fs can be calculated by dividing decimally the calculation count value with 1/2000th of the XIN input frequency. For details, see Chapter 12. Microcontroller Interface.
- Since the XIN clock serves as the reference for internal processing, complete the XINSEL setting prior to bi-phase data input.
- Supply XIN with clocks all the time to be used in the following applications.
  - (1) Detection whether or not bi-phase data is input
  - (2) Clock source while PLL is unlocked
  - (3) Calculation of input data sampling frequency
  - (4) Time definition when switching input data
  - (5) External source of supply clock (clock for an AD converter, etc.) in XIN source mode.
- The oscillation amplifier automatically stops while PLL is locked. However, it can be also set for continuous operation with AMPOPR[1:0]. In the continuous operation mode, data detection and calculation of input sampling frequency become possible while the PLL is locked. In that case, both the oscillator amplifier clock and the PLL clock signals coexist, and then users must pay attention and make sure sound quality is not adversely affected.
- If the oscillation amplifier is set to continuous operation with AMPOPR[1:0] while PLL is locked, RERR temporarily outputs an error ("H"). When oscillation amplifier is switched to an operation state, fs calculation value maintained during a stop state is reset at the same time. This process is regarded as an error, since fs seems to change. This error has no influence on clock output, but RDATA is muted during this error period. Therefore, setting of the AMPOPR[1:0] must be completed either prior to bi-phase data input or while PLL is unlocked.
- The oscillation amplifier can be stopped if it is unnecessary. However, when the normal operation is resumed, it must wait for 10ms or longer until the resonator oscillation gets stable.
- XMCK outputs the XIN clock. The XMCK output is set with XMSEL[1:0]. The XIN clock can be set to 1/1, 1/2, or muted output.
- When only the modulation function is used, no clock needs to be supplied to XIN. In this case, the built-in oscillation amplifier and frequency divider can be also used for MCK, BCK, and LRCK clock generation. If you use only the oscillation amplifier, input the quartz resonator to XIN and XOUT or an external clock to XIN, and fix the electric potential of digital data input pins of RX0 to RX6. At this time, do not set to stop the DIR function with RXOPR and PLLOPR. The output clock may be muted.

#### 10.1.4 Switching between Master clock and clock source

- The RMCK, RBCK, and RLRCK (hereunder, R system), and the SBCK and SLRCK (hereunder, S system) clock sources can be selected among the following three master clocks.
  - (1) PLL source (256fs or 512fs)
  - (2) XIN source (12.288MHz or 24.576MHz)
  - (3) TMCK source (256fs or 512fs)
- There are two ways available for clock source switching; one is to set with the R system and the S system interlocked, and the other is to set only the R system while XIN source is fixed in the S system. This setting is carried out with SELMTD, OCKSEL, and RCKSEL.
- The clock source is automatically switched between PLL clock and XIN clock by locking/unlocking the PLL. During this period, continuity of the clock is maintained. However, if the clock source is switched with SELMTD, continuity of the S system is not maintained.
- The clock source can be switched to XIN with OCKSEL and RCKSEL, regardless of the PLL status. The clock source switch command and each clock output of the R and S systems are shown below.

Table 10.1 Correspondence between Clock Source Switch Commands and Clock Output Pins

SELMTD	R System Output Clock	S System Output Clock
0	According to OCKSEL	According to OCKSEL
1	According to RCKSEL	Fixed to XIN source

Table 10.2 Relationship between Clock Source Switch Commands and Clock Sources when PLL Locked/Unlocked

SELMTD OCKSEL		RCKSEL	R System Clock Source		S System Clock Source	
	OCKSEL	RCKSEL	Locked	Unlocked	Locked	Unlocked
0	0	х	PLL	XIN	PLL	XIN
	1	х	XIN	XIN	XIN	XIN
	х	0	PLL	XIN	XIN	XIN
	х	1	XIN	XIN	XIN	XIN

• TMCK source should be selected with EXYSNC and the input clock frequency (256fs or 512fs) should be set with PLLSEL. The same action as the one of PLL source should be taken except inputting clock from TMCK on this setting.

• When data synchronized with the TMCK source is input, various clocks are output with the TMCK source as the master clock, in a manner similar to the PLL clock status. In this case as well, the source is switched to XIN with OCKSEL and RCKSEL. When the TMCK source is not supplied or the input data is not synchronized, the source is switched to the XIN source, in a manner similar to the PLL source unlocked status.

• The PLL status can be always monitored with RERR even after switching to the XIN source. Moreover, the processed information can be read with the microcontroller interface regardless of the PLL status.

• When the PLL changes from the locked status to the unlocked, the timing for switching the clock from the PLL source to the XIN source can be changed with XTWT [1:0]. Use these commands if noise occurs during clock switching.

#### 10.1.5 Points to notice about switching clock source while PLL is locked

- In the state where the PLL is locked, if the clock is switched to XIN source with SELMTD, OCKSEL, and RCKSEL while the oscillator amplifier is stopped (initial setting), clock continuity is maintained but RERR temporarily outputs an error (high level) indication. When switched to XIN source, the oscillator amplifier is switched to the operating state at the same time. Consequently the input fs calculation restarts. At this time, the previous fs calculation value is reset and compared with the newly calculated fs value. Then those two values are found not identical, that's why the error is temporarily issued.
- The following settings are required to switch the clock source with SELMTD, OCKSEL, and RCKSEL without changing the RERR status while PLL is locked.
  - (1) Set the oscillation amplifier to the continuous operation mode with AMPOPR[1:0].
  - (2) Set with FSERR to the mode where fs change is not reflected to the error flag.
- By one of the above settings, changing of the RERR status can be constrained when the clock source is switched with SELMTD, OCKSEL, and RCKSEL.
- When switching the clock source to XIN from the state where the oscillation amplifier is stopped while the PLL is locked, the output clock using XIN as the source starts being output after the oscillation amplifier starts operating. When the PLL is locked, switching of the clock source from XIN to PLL is performed instantaneously. In either case, clock continuity is maintained.

#### 10.1.6 Master clock block diagram (TMCK, XIN, XOUT, RMCK, XMCK)

• The relationships between the three master clocks, switching, and the frequency division function, are described below.

- The contents in the square brackets [\*\*\*] by the switch and function blocks correspond to the write command names.
- Lock/Unlock is automatically switched by PLL locking/unlocking.

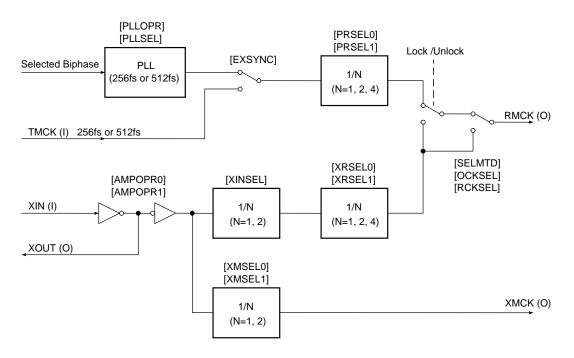


Figure 10.2 Master Clock Block Diagram

#### 10.1.7 Output clocks (RMCK, RBCK, RLRCK, SBCK, SLRCK)

• The LC89057W-VF4A-E features two clock systems (R and S systems) in order to supply the various needed clocks to peripheral devices such as A/D converter and DSP.

• The clock output settings for the R and S systems are done with PRSEL[1:0], XRSEL[1:0], XRBCK[1:0],

XRLRCK[1:0], PSBCK[1:0], PSLRCK[1:0], XSBCK[1:0], and XSLRCK[1:0].

• Setting range for each clock output pin when the PLL is used as source

(1) RMCK: Selection from 1/1, 1/2, and 1/4 of 512fs or 256fs

(2) RBCK: 64fs output

(3) RLRCK: fs output

(4) SBCK: Selection from 128fs, 64fs, and 32fs

(5)SLRCK: Selection from 2fs, fs, and fs/2

• Setting range for each clock output pins when the XIN is used as source

(1) RMCK: Selection from 1/1, 1/2, and 1/4 of 12.288MHz or 24.576MHz

(2) RBCK: Selection from 12.288MHz, 6.144MHz, and 3.072MHz

(3) SBCK: Selection from 12.288MHz, 6.144MHz, and 3.072MHz

(4) RLRCK: Selection from 192kHz, 96kHz, and 48kHz

(5) SLRCK: Selection from 192kHz, 96kHz, and 48kHz

• Setting range for each clock output pins when the TMCK is used as source

(1) RMCK: selection from 1/1, 1/2,1/4 of 512fs or 256fs.

(2) RBCK: 64fs output

(3) RLRCK: fs output

(4) SBCK: selection from 128fs, 64fs, 32fs

(5) SLRCK: selection from 2fs, fs, fs/2

• The polarity of RBCK, RLRCK, SBCK, and SLRCK can be reversed with RBCKP, RLRCKP, SBCKP, and SLRCKP.

• Clock switching is processed from the rising edge of RLRCK output after the falling edge of microcontroller interface CE.

Output Pin Name	PLL Source (In	rce (Internal VCO CK) TMCK Source (TMCK input CK)		TMCK Source (TMCK input CK) XIN Source (XIN input C		XIN input CK)
Output Fin Name	512fs	256fs	512fs	256fs	12.288MHz	24.576MHz
RMCK	512fs <b>256fs</b> 128fs	256fs <b>128fs</b> 64fs	512fs <b>256fs</b> 128fs	256fs <b>128fs</b> 64fs	<b>12.288MHz</b> 6.144MHz 3.072MHz	<b>24.576MHz</b> 12.288MHz 6.144MHz
RBCK	64fs				12.288MHz 6.144MHz <b>3.072MHz</b>	
RLRCK	fs			961	kHz Hz t <b>Hz</b>	
SBCK	128fs 64fs 32fs				12.288MHz 6.144MHz <b>3.072MHz</b>	
SLRCK	2fs <b>fs</b> fs/2			961	kHz Hz K <b>Hz</b>	

Table 10.3 List of Output Clock Frequencies (Bold Items = Initial Settings)

#### 10.1.8 Output clocks block diagram (RMCK, RBCK, RLRCK, SBCK, SLRCK, XMCK)

- The relationships between the output clock and switch function are shown below.
- PLL in the figure indicates the PLL source (or TMCK source), and XIN the XIN source.
- The contents in the square brackets [\*\*\*] by the switch function blocks correspond to the write command names.
- The broken lines connecting the switches indicate coordinated switching.
- Lock/Unlock is switched automatically by PLL locking/unlocking.
- Master/Slave is switched by master/slave function switching of demodulation function.

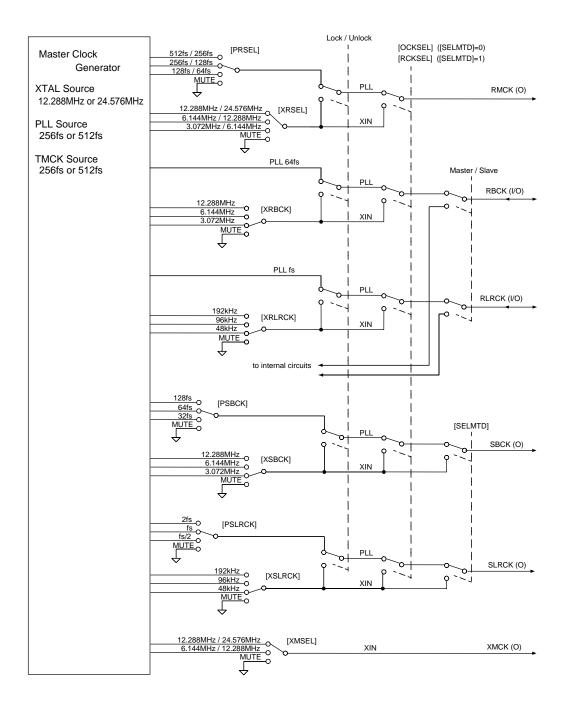
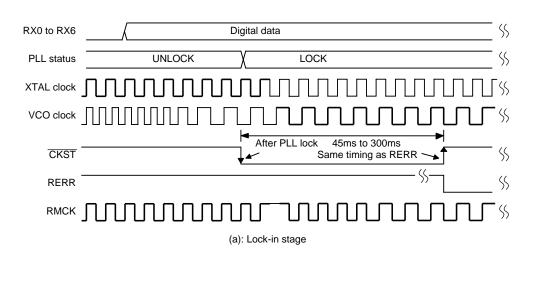


Figure 10.3 Clock Output Block Diagram

#### 10.1.9 Output of Clock switch transition signal (CKST)

- CKST outputs "L" pulse when the output clock changes by PLL lock/unlock.
- In the lock-in stage, the CKST "L" pulse falls at the word clock generated from the XIN clock after PLL is locked following detection of input data, and rises at the same timing as RERR after a designated period.
- In the unlock stage, the CKST "L" pulse falls at the same timing as RERR, PLL lock detection signal, and rises after word clocks generated from the XIN clock are counted for a designated period.
- Change of the PLL lock status and timing of the clock change can be seen by detecting the rising and falling edges of the CKST "L" pulse.



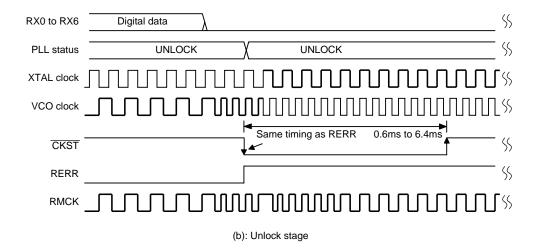


Figure 10.4 Clock Switch Timing

#### 10.2 Bi-phase Signal I/O

#### 10.2.1 Reception range of bi-phase signal input

• Reception range of the input data depends on the PLL lock frequency setting done with PLLSEL. The relationship between this setting and the guaranteed reception range is shown below.

Table 10.4 Rela	ationship between H	PLL Output Clock	c Setting and Recer	ption Range (FSLIN	f[1.0] = 00
1 abic 10.7 Kela	utonship between i	LL Output Clock	x beams and Recep	puon Range (1 DLin	1   1.0   = 0.0

PLL Output Clock Setting	Input Data Reception Range	
512fs (PLLSEL = 0)	28kHz to 105kHz	
256fs (PLLSEL = 1)	28kHz to 195kHz	

• The fs reception range for input data can be limited within the set range of PLL output clocks stated above. This setting is carried out with FSLIM [1:0]. When this function is adopted, input data exceeding the set range is considered as an error, the clock source is automatically switched to the XIN source, and RDATA output data is subject to the RDTSEL setting.

#### 10.2.2 Bi-phase signal I/O pins (RX0 to RX6, RXOUT)

- There are 7 kinds of digital data input pins. Moreover, data modulated with the modulation function is also available and thus there are 8 options in total. However, the pins to be selected are restricted, depending on the setting conditions.
  - (1) The six pins of RX0 and RX2 to RX6 are TTL level input pins with 5V-tolerance voltage.
  - (2) RX1 is an input pin with built-in amplifier, which is coaxial-compatible and it, can receive up to min, 200mVp-p data.
- The demodulation input and RXOUT output signals could each be selected independently.
  - (1) The demodulation data is selected with RISEL [2:0].
  - (2) The RXOUT output data is selected with ROSEL [2:0].
- RXOUT can be muted with RXOFF. Muting is recommended to reduce clock jitter when RXOUT is not used.
- The data input status can be monitored with the RXMON setting. The status of each data input pin is stored in CCB address 0xEA and output registers DO0 to DO7. Since this function uses the XIN clock, the oscillation amplifier must be set to the continuous operation mode when RXMON is set.
- Demodulation input pin can be switched via PLL unlock with the ULSEL setting. Thus data switching can be accurately conveyed to peripheral devices.

The interval from pin switching through RISEL [2:0] until the data is received is about 250µs to 350µs. In this function, the oscillation amplifier also needs to be set to the continuous operation mode.

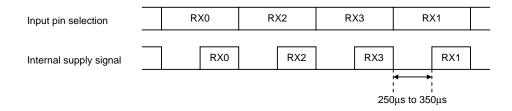
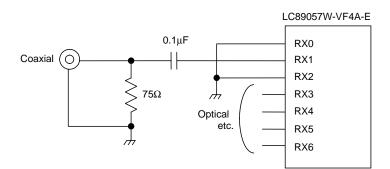


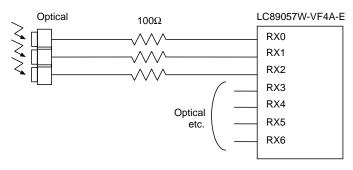
Figure 10.5 Input Pin Selecting Process via PLL Unlock

#### 10.2.3 Bi-phase signal input circuits (RX0, RX1, RX2)

- If RX1 with a built-in amplifier is used as a coaxial input pin, malfunction may occur due to the influence from the adjacent RX0 and RX2 input pins. To avoid the influences from those pins, fix RX0 and RX2 to "L".
- When RX1 is selected and the input signal to RX1 is temporarily open because of AC coupling, the RX0 and RX2 potential must be fixed. In this case, there are 5 bi-phase signal input pins available, which are RX1 and RX3 to RX 6.
- When RX1 is selected and the input signal to RX1 is always fixed to either "H" or "L", RX0 and RX2 processes are not required. In this case, all 7 input pins can be used validly.



(a):Coaxial input circuit

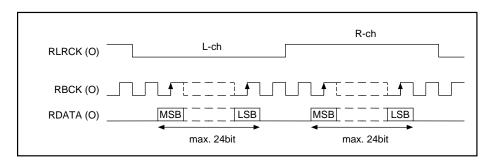


(b):Optical input circuit

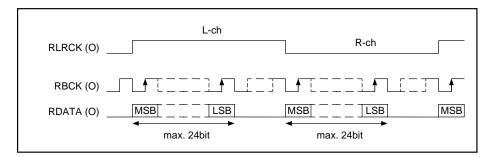
Figure 10.6 Bi-Phase Signal Input Circuits

# 10.3 Serial Audio Data I/O

- 10.3.1 Output data format (RDATA)
- The output format is set with OFSEL [2:0].
- The initial value of output format is  $I^2S$ .
- Right-adjusted output is valid only in the master mode. In the slave mode, data is not output correctly.
- Output data is output synchronized with the RLRCK edge immediately after the RERR output becomes "L".



#### (0): I<sup>2</sup>S data output



(1): MSB-first front-loading data output

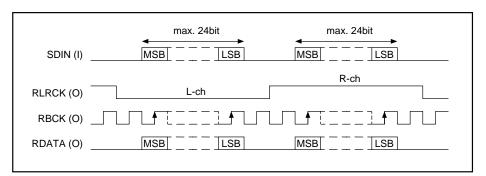
L-ch	R-ch
RDATA (O) LSB MSB LSB	
16, 20, 24bit	16, 20, 24bit

(2): MSB-first back-loading data output

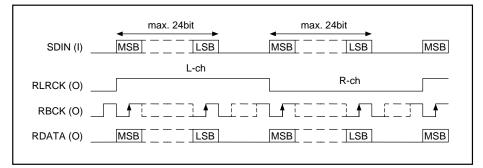
Figure 10.7 Data Output Timing

#### 10.3.2 Serial audio data input format (SDIN)

- Serial digital audio data input pin of SDIN capable of 24 bits input is provided.
- The format of the serial audio data input to SDIN and the demodulation data output format must be identical. The initial value of modulation data output is  $I^2S$ .



#### (0): I<sup>2</sup>S data input



(1): MSB-first front-loading data input

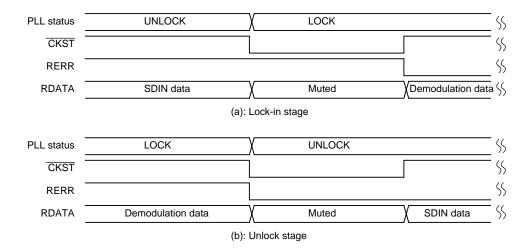
SDIN (I) LSB	16, 20	0, 24bit LSB	16, 20	, 24bit
RLRCK (0)	L-ch		R-ch	
RBCK (O)				
RDATA (O) LSB	MSB	LSB	MSB	LSB

(2): MSB-first back-loading data input

Figure 10.8 Serial Audio Data Input Timing

#### 10.3.3 Output data switching (SDIN, RDATA)

- RDATA outputs demodulation data when the PLL is locked, and outputs SDIN input data when the PLL is unlocked. This output is automatically switched according to the PLL locked/unlocked status. For details, see the timing charts below.
- When SDIN input data is selected, switch to a clock source synchronized to the SDIN data.
- With the RDTSTA setting, the SDIN input data is output to RDATA regardless of the locked/unlocked status of the PLL.
- With the RDTMUT setting, the RDATA output data can be also muted forcibly.
- Even when the clock source is set to XIN with OCKSEL and RCKSEL, the PLL continues operating as long as the PLL is not stopped with PLLOPR. At this time, the PLL status is continuously output from RERR unless error output is forcibly set with RESTA. Moreover, the processed information can be read with the microcontroller interface regardless of the PLL status.

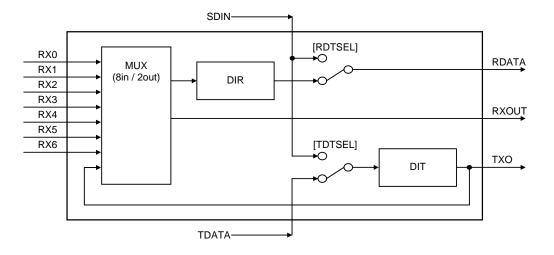




# LC89057W-VF4A-E

#### 10.3.4 Data block diagram (RX0 to RX6, TX0, RXOUT, TDATA, RDATA, SDIN)

- The RDATA output data can be switched to SDIN input data with RDTSEL.
- The SDIN input data can be input to the modulation function with TDTSEL.
- Since the modulation output is input to the input switch multiplexer, it can be fetched from RXOUT. Using this function, it is possible to use a signal digitized with the A/D converter for digital recording output, etc.



#### Figure 10.10 Data System Diagram

#### 10.3.5 Calculation of input data sampling frequency

- The input data sampling frequency is calculated using the XIN clock.
- In the mode where the oscillation amplifier automatically stops according to the lock status of the PLL, the input data sampling frequency is calculated during the RERR error period and completed when the oscillation amplifier stops with holding the value. Therefore, the value remains unchanged until the PLL becomes unlocked.
- If the oscillation amplifier is in a continuous operation mode, calculation is repeated constantly. Even if sampling changes within the PLL capture range for input data whose channel status sampling information does not change, the calculation results that follow the input data can be read.
- The calculation result can be read from CCB address 0xEB and output registers DO4 to DO7 and DO8 to DO15. Registers DO4 through DO7 hold the encoded result, while DO8 through DO15 hold the calculated counter value. However, as the calculation count value is output in 8 bit units, fs capable of being calculated are greater than 24kHz. For details, see Chapter 12. Microcontroller Interface.

#### **10.4 Error Output Processing**

#### 10.4.1 Lock error and data error output (RERR)

- RERR outputs an error flag when a PLL lock error or a data error occurs.
- It is possible to treat non-PCM data reception as an error by the RESEL setting.
- The RERR output conditions are set with RESTA. Since the PLL status can be output at all times, the PLL status can be always monitored, even when the clock source is XIN.

#### 10.4.2 PLL lock error

- The PLL gets unlocked for input data that lost bi-phase modulation regularity, or input data for which preambles B, M, and W cannot be detected.
- RERR turns to "H" upon occurrence of a PLL lock error, and returns to "L" when data demodulation returns to normal and "H" is maintained for somewhere between 45ms and 300ms.
- The rising and falling edges of RERR are synchronized with RLRCK.

#### 10.4.3 Input data parity error

- Odd number of errors among parity bits in input data and input parity errors are detected.
- If an input parity error occurs 9 or more times in succession, RERR turns to "H" indicating that the PLL is locked, and after holding "H" for somewhere between 45ms and 300ms, it returns to "L".
- The error flag output format can be selected with REDER, when an input parity error is output less than 9 times in succession.

#### 10.4.4 Other errors

- Even if RERR turns to "L", the channel status bits of 24 to 27 (sampling frequency) are always fetched and the data of the previous block is compared with the current data. Moreover, the input data sampling frequency is calculated from the fs clock extracted from the input data, and the fs calculated value is compared in a same way as described above. If any difference is detected in these data, RERR is instantly made "H" and the same processing as for PLL lock errors is carried out.
- The PLL causes a lock error when the fs changes as described above. However, in order to support sources with a variable fs (for example a CD player with a variable pitch function), it is possible to set with FSERR not to output an error flag unless fs changes exceeding the PLL capture range.

Moreover, in the FSERR setting, when the PLL is locked, RERR is turned to "L" without reflecting the fs calculation result to the error flag concerning input data within reception range by FSLIM[1:0].

• If a setting which regard non-PCM data input as an error is made with RESEL, RERR turns to "H" when non-PCM data input is detected. At this time, the PLL locked status and various output clocks are subject to the input data, but the output data is muted.

#### 10.4.5 Data processing upon occurrence of errors (lock error, parity error)

- The data processing upon occurrence of an error is described below. If 8 or fewer input parity errors occur in succession and transfer data is PCM audio data, the data is replaced by the one saved each in L-ch and R-ch in the previous frame. However, if the transfer data is non-PCM data, the error data is output as it is. Non-PCM data is the data of when bit 1 non-PCM data detection bit of the channel status turns to "H" based on the data detected prior to the occurrence of the input parity error.
- Output data is muted when a PLL lock error occurs or a parity error occurs 9 or more times in succession.
- As for the channel status output, the data of the previous block is held in 1-bit units when a parity error occur 8 or fewer times in succession.

Data	PLL Lock Error	Input Parity Error (a)	Input Parity Error (b)	Input Parity Error (c)			
RDATA output	"L"	"L"	Previous value data	Output			
fs calculation result	"L"	Output	Output	Output			
Channel status	"L"	"L"	Previous value data	Previous value data			
Validity flag	"L"	"L"	Output	Output			
User data	"L"	"L"	Output	Output			

\* Input parity error (a): If occurs 9 or more times in succession

\* Input parity error (b): If occurs 8 or fewer times in succession, in case of audio data

\* Input parity error (c): If occurs 8 or fewer times in succession, in case of non-PCM burst data

• Figure 10.11 shows an example of data processing upon occurrence of a parity error.

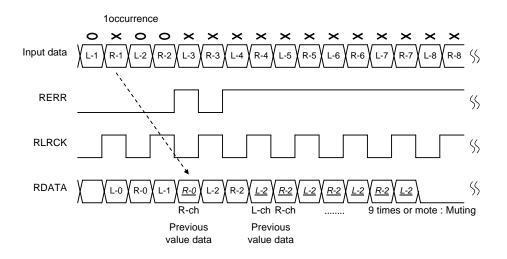
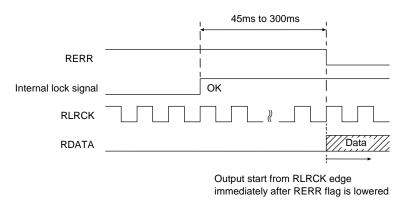
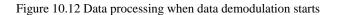


Figure 10.11 Example of Data Processing upon Parity Error Occurrence

#### **10.4.6 Processing during error recovery**

- When preambles B, M, and W are detected, PLL becomes locked and data demodulation begins.
- RDATA output data is output from the RLRCK edge after RERR turns to "L".





#### 10.5 Channel Status Data Output

#### 10.5.1 Data delimiter bit 1 output (AUDIO)

- AUDIO outputs bit 1 of the channel status that indicates whether the input bi-phase data is PCM audio data. AUDIO is immediately output upon detection of RERR even during "H" output period.
- OR-output with IEC61937 or with the DTS-CD/LD detection flag is also possible with AOSEL.

Table	10.6	AUDIO	Output
-------	------	-------	--------

AUDIO Output Conditions				
L	PCM audio data (CS bit 1 = "L")			
Н	Non-audio data (CS bit 1 = "H")			

#### 10.5.2 Emphasis information output (EMPHA)

• EMPHA outputs shows whether there are 50/15µs emphasis parameters for consumer and broadcast studio. EMPHA is immediately output upon detection of RERR even during "H" output.

#### Table 10.7 EMPHA Output

EMPHA Output Conditions				
	L	No pre-emphasis		
	Н	50/15µs pre-emphasis		

#### 10.6 Other Outputs

#### 10.6.1. Validity flag output (VO)

- The validity flag can be output from AUDIO/VO by switching the contents of AUDIO/VO output by VOSEL.
- The validity flags transferred in units of each sub-frame are output in the following timing.
- The validity flag is generated 0.5 to 1 frame earlier than the output data in error.

Table 10.8 V	O Output
--------------	----------

VO	Output Conditions				
L	No error (not burst data)				
н	Error (May be burst data)				

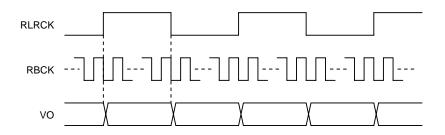


Figure 10.13 Validity Flag Output Timing

#### 10.6.2 User data output (UO)

• User data can be output from EMPHA/UO/CO by switching the contents of EMPHA/UO/CO output by UOSEL.

- The UOSSEL setting, however, is enabled only when PESEL1 is set to 0; it is disabled if PBSEL1 is set to 1. The state of PBSEL0 has nothing to do with this processing
- The user data transferred in units of each sub-frame are output in the following timing.

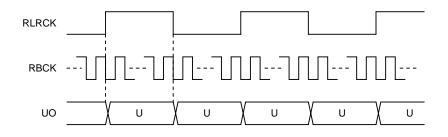


Figure 10.14 User Data Output Timing

#### 10.6.3 Channel status data output (CO)

- Possible to output channel status data from EMPHA/UO/CO by switching PBSEL1 that performs the setting of Preamble B synchronization signal output.
- Polarity of RLRCK is uncertain because channel status data loads data and outputs them on each sub-flame. However, the timing for a period of H output of preamble B synchronization signal PB and bit 0 data output (c0 Lch, c0 Rch) of channel status is shown on the following figure.

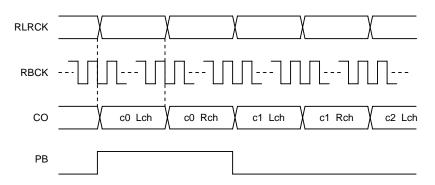


Figure 10.15 Channel Status Data Output Timing

#### 10.6.4 Preamble B synchronization signal output (PB)

- Possible to output preambles B synchronization signal that is block synchronization of channel status from  $\overline{\text{CKST}/\text{PB}}$  by switching the content of  $\overline{\text{CKST}/\text{PB}}$  output by PBSEL [1:0].
- For the period that bit 0 data of the channel status is output, PB signal outputs H. For the otherwise period, it outputs L.
- Regarding PBSEL [1:0], possible to output preamble B synchronization signal with DIT function. However, impossible to set output preamble B with DIR function and DIT function from PB at once because they share the terminal.
- In case of setting preamble B synchronization signal output with DIR function, the channel status data is output from EMPHA/UO/CO pin, and the setting of UOSEL is invalid.

#### 10.7 IEC61937, DTS-CD/LD Detection Flag Output

- A function to output IEC61937 and DTS-CD/LD detection flags for Non-PCM data is provided.
- When the UNPCM of non-PCM signal output setting is selected through the INT output contents setting, an interrupt signal is output from INT detecting an IEC61937 or DTS-CD/LD sync signal. Reading output register from this information can see details of Non-PCM signal.
- When bit 1 of channel status is non-PCM data ("1"), the IEC61937 sync signal is detected and output. If bit 1 is PCM data, the IEC61937 sync signal is not output.
- DTS-CD/LD sync signal detection is done based on the sync pattern and the base frequency. DTS-ES data detection is output when the DTS5.1 channel sync signal is detected and the DTS-ES sync pattern is verified.
- The IEC61937 and DTS-CD/LD detection flags are cleared when fs have changed or a PLL lock error or data error has occurred.
- Since the DTS sync signal is provided within the audio data, digital data with the same code as the DTS sync signal may exist in rare cases for regular CD/LD records that are not recorded in the DTS format. Protection using the sync pattern or base frequency is provided so that such data is not misinterpreted as DTS-CD/LD detection flags. The detection sequence is shown below.

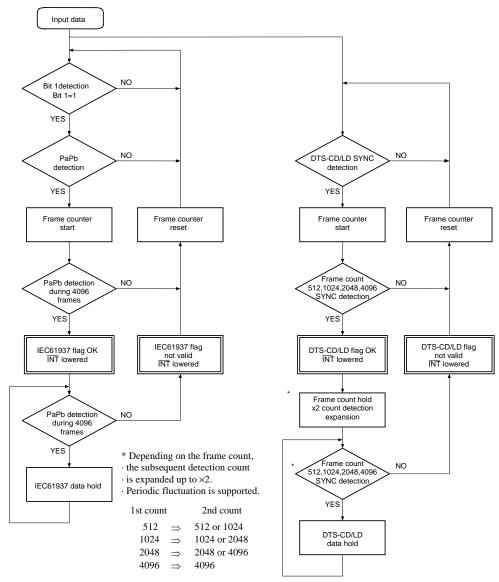


Figure 10.16 IEC61937 and DTS-CD/LD Data Detection Sequence

### 11. Description of Modulation Function and General-Purpose I/Os

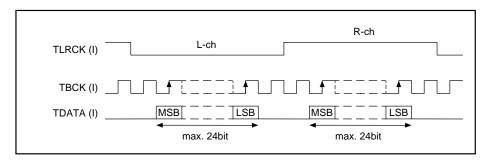
#### **11.1 How to Use Modulation Function**

#### 11.1.1 Initial setting

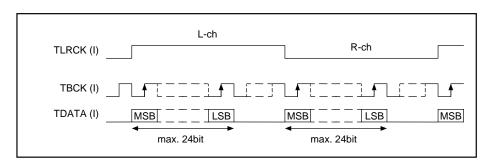
- The modulation function and general-purpose I/O port function cannot be used simultaneously because they share the same pins. To select the modulation function, pull down  $\overline{INT}$  with a 10k $\Omega$  resistor. For further information about the setting, see Chapter 9.
- In the initial setting, the modulation function is stopped. To apply the modulation function, set it with TXOPR.

#### 11.1.2 Data output (TMCK, TBCK, TLRCK, TDATA, TXO)

- Output bi-phase modulated data from TXO by inputting 256fs or 128fs clock into TMCK, 64fs clock into TBCK, fs clock into TLRCK, audio data into TDATA.
- Set TCKSEL for clock frequency to input into TMCK. However, the falling edge of TBCK is in synchronization with the rising edge for TMCK when the TMCK is set at 256fs. Also, the falling edge of TMCK is in synchronization with the falling edge of TBCK when TMCK is set at 128fs.
- The polarity of the TLRCK clock is set with TXLRP.
- Input data can be modulated in the sampling range of 32kHz to 192kHz, in the transfer rate of 4MHz to 25MHz, and up to 24-bit data.
- The initial value for the input data format is set in I<sup>2</sup>S. Switching to MSB-first right-adjusted input is set with TXDFS.
- For the channel status, the first 48 bits of data can be written with the microcontroller interface.
- TXO is fixed to "L" by setting TXOPR to stop or TXMUT.



(0): I<sup>2</sup>S data output



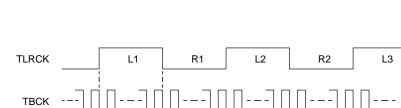
(1): MSB-first front-loading data output

Figure 11.1 Data Input Timing

#### 11.1.3 Validity flag input (VI)

- Validity flags can be input from RX5/VI by switching the contents of RX5/VI input by VISEL.
- The timing of writing a validity flag is shown below. The validity flag can be also written with the microcontroller interface, but port settings have priority over the validity flag.
- Writing validity flags with the microcontroller interface is done using VMODE.

Table 11.1 RX5/V1 Input									
RX5/	VI	Output Conditions							
0			No e	error					
1	1			ror					
TLRCK	L1	R1	L2	R2	L3				



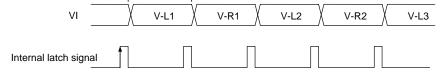


Figure 11.2 Validity Flag Input Timing

#### 11.1.4 User data input (UI)

- User data can be input from RX6/UI by switching the contents of RX6/UI input by UISEL.
- The timing of writing the user data is shown below.
- It is also possible to write user data using the preamble B sync signal as the reference. Generation of the preamble B sync signal is configured in PBSEL[1:0] as in the case of the DIR function. After the setting, the signal is output from CKST/PB.

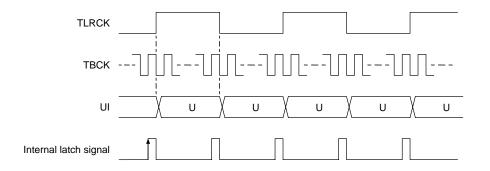


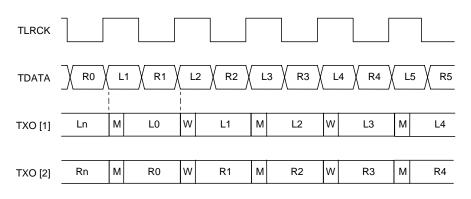
Figure 11.3 User Data Input Timing

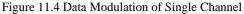
#### 11.1.5 Modulated output of SDIN input data

- SDIN input data is modulated and its output can be fetched from TXO and RXOUT.
- To modulate SDIN input data, set it with TDTSEL.
- Input a clock synchronized with SDIN to TMCK, TBCK, and TLRCK.
- The SDIN input data format must be identical to the setting used during modulation processing.

#### 11.1.6 Monaural output

- It is possible to output only single channel data of the input data at half the rate of the input fs with TXMOD[1:0].
- This operation maintains the bi-phase modulation regularity, but there is no correlation between the data and preambles.
- Channel status write is synchronized with the output rate.
- The validity flag and user data are written in units of frame. Input the same data to the L and R channels.
- To process the stereo signals of two channels with this setting, two units of LC89057W-VF4A-E are required.





#### 11.2 General-Purpose I/Os (PIO0, PIO1, PIO2, PIO3 PIOEN)

#### 11.2.1 Initial settings

- The modulation function and general-purpose parallel I/Os share the same pins and therefore they cannot be used simultaneously. To use the general-purpose I/Os, pull up  $\overline{INT}$  with a 10k $\Omega$  resistor. For further information about the setting, see Chapter 9.
- The general-purpose parallel I/O applies parallel-conversion to the serial data input from the microcontroller interface, and outputs it from PIO0, PIO1, PIO2, and PIO3. The input function saves the parallel data input to PIO0, PIO1, PIO2, and PIO3 in internal registers and reads the contents of these registers with the microcontroller interface.
- 4-bit general-purpose I/Os cannot be used with both input and output mixed. Switching between input and output is done with PIOEN. When PIOEN is "H", all the general-purpose I/Os become input pins. When PIOEN is "L", all the general-purpose I/Os become output pins.

#### 11.2.2 I/O settings

- Data handling for general-purpose I/Os is done using the microcontroller interface and write/read registers. See Chapter 12 Microcontroller Interface for details.
- General-purpose I/O writes settings (Microcontroller  $\rightarrow$  Write register  $\rightarrow$  General-purpose I/O output)

(1) To output data from general-purpose I/Os, set PIOEN to "L".

- (2) Set the data to be output to CCB address 0xE8, command address 0x10, and input registers DI12 to DI15.
- (3) During write operation, be sure to input "0" to DI8 to DI11 of modulation setting registers.
- (4) The data written to PI0 to PI3 is output from the general-purpose I/Os.

 $\bullet \text{ General-purpose I/O read settings (General-purpose I/O input \rightarrow \text{Read register} \rightarrow \text{Microcontroller})}$ 

- (1) To input data to general-purpose I/Os, set PIOEN to "H".
- (2) The input data is saved in CCB address 0xEB and output registers DO0 to DO3.
- (3) Data can be sent to the microcontroller by reading PO0 to PO3.

## 12. Microcontroller Interface (INT, CL, CE, DI, DO)

#### **12.1 Description of Microcontroller Interface**

#### 12.1.1 Interrupt output (INT)

• Interrupts are output when a change has occurred in the PLL lock status or output data information.

- Interrupt output consists of the register for selecting the interrupt source, the INT pin that outputs that state transition, and the registers that store the interrupt source data.
- Normally INT outputs "L" upon occurrence of an interrupt while "H" is output. Following "L" output, it returns to "H" according to the INTOPF setting.
- INTOPF determines whether to hold the "L" pulse for a certain period and then clear it ("H"), or to clear it at a time when the output register is read.
- The interrupt sources can be selected among the following items. Multiple sources can be selected at the same time with the contents of CCB address 0xE8 and command address 0x08. INT outputs OR calculation result of the selected interrupt sources.

 $\overline{\text{INT}}$  output = (selected source 1) + (selected source 2) +  $\cdots$  + (selected source n)

No.	Command Name	Description
1	ERROR	Output when RERR pin status has changed
2	INDET	Output when input data pin status has changed (subject to oscillation amplifier operation condition)
3	FSCHG	Output when input fs calculation result has changed. (subject to oscillation amplifier condition)
4	CSRNW	Output when channel status data of first 48 bits have updated
5	UNPCM	Output when AUDIO pin status has changed
6	PCRNW	Output when burst preamble Pc has been updated
7	SLIPO	Output when data is read twice during slave setting and missing data is detected
8	EMPF	Output when emphasis information has changed

Table 12.1	Interrupt	Source	Setting	Contents
14010 1211	meenape		Secting	contento

- The contents of set interrupt source are saved in output registers DO8 to DO15 of CCB address 0xEA, when the source occurs. However, for the read registers for source items 1 and 5, the each status of the RERR and AUDIO pins are output at the time of reading. Other data except for source items 1 and 5 are saved in the registers upon occurrence of an interrupt source.
- Concerning source items 2 and 3, the oscillation amplifier clock is used. Therefore, if the status is monitored even while the PLL is locked, the oscillation amplifier must be set to the continuous operation mode.
- Clearing  $\overline{INT}$  at the same time of readout of an output register is carried out immediately after the output register 0xEA is set.
- The pulse width of the setting in which the INT output following the occurrence of an interrupt source is set to the "L" pulse output mode is somewhere between 1/2fs and 3/2fs for one interrupt source.

#### 12.1.2 CCB format

- The various function settings as well as information writing and reading are performed with the microcontroller interface.
- The data format of the microcontroller interface conforms to Sanyo's original serial bus format (CCB), but three-state is employed instead of open-drain for the data output format.
- Data input/output is performed following CCB address input. For the data input/output timing, see the input/output timing chart.

Tuble 12.2 Relationship between Register 1/0 Contents and COD Readesses										
Register I/O contents	R/W	CCB address	B0	B1	B2	B3	A0	A1	A2	A3
Function setting data input	Write	0xE8	0	0	0	1	0	1	1	1
CS data input	Write	0xE9	1	0	0	1	0	1	1	1
Interrupt data output	Read	0xEA	0	1	0	1	0	1	1	1
fs data output	Read	0xEB	1	1	0	1	0	1	1	1
CS data output	Read	0xEC	0	0	1	1	0	1	1	1
Pc data output	Read	0xED	1	0	1	1	0	1	1	1

Table 12.2 Relationship between Register I/O Contents and CCB Addresses

#### 12.1.3 Data write procedure

- Input is performed in the following sequence: CCB addresses of A0 to A3 and B0 to B3, chip addresses of DI0 and DI1, command addresses of DI4 to DI7, and data of DI8 to DI15. DI2 and DI3 are reserved for the system. Input must be doing "0".
- For the chip addresses, DI0 corresponds to CAL (low-order), and DI1 to CAU (high-order). For details, see section 9.2.

#### 12.1.4 Data read procedure

- Read data is output from DO. DO is in the high impedance state when CE is "L", and begins outputting from the rising edge of CE after output setting is established at the CCB address. DO then returns to the high impedance state at the falling edge of CE.
- If DO outputs are shared using multiple LC89057W-VF4A-E units, it is possible to set the DO outputs of the LC89057W-VF4A-E units of which data is not to be read to be always in the high impedance state with DOEN. With this setting, only the targeted outputs can be read.

#### 12.1.5 I/O timing

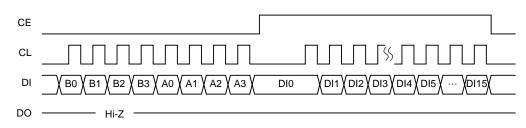


Figure 12.1 Input Timing Chart (Normal L clock)

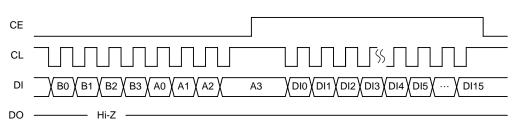


Figure 12.2 Input Timing Chart (Normal H clock)

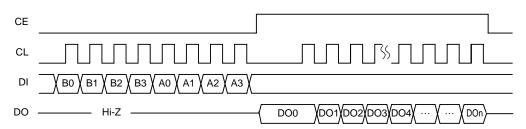


Figure 12.3 Output Timing Chart (Normal L clock)

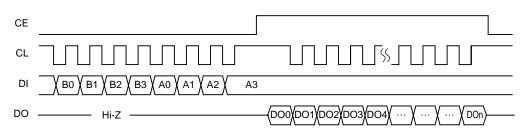


Figure 12.4 Output Timing Chart (Normal H clock, DO0 need be read with port)

## 12.2 Write Data

### 12.2.1 List of write commands

• A list of the write commands is shown below.

• To write the commands shown in the following table, set the CCB address to 0xE8.

Add.	Setting Items	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8
0	All system setting	TESTM	0	TXOPR	RXOPR	INTOPF	0	DOEN	SYSRST
1	Demodulation system setting	PBSEL1	PBSEL0	FSLIM1	FSLIM0	RXMON	AOSEL	VOSEL	UOSEL
2	Master clock	AMPOPR1	AMPOPR0	EXSYNC	PLLOPR	XMSEL1	XMSEL0	XINSEL	PLLSEL
3	R system output clock	XRLRCK1	XRLRCK0	XRBCK1	XRBCK0	XRSEL1	XRSEL0	PRSEL1	PRSEL0
4	S system output clock	XSLRCK1	XSLRCK0	XSBCK1	XSBCK0	PSLRCK1	PSLRCK0	PSBCK1	PSBCK0
5	Source switch	0	RDTMUT	RDTSTA	RDTSEL	0	RCKSEL	OCKSEL	SELMTD
6	Data input/output	RXOFF	ROSEL2	ROSEL1	ROSEL0	ULSEL	RISEL2	RISEL1	RISEL0
7	Output format setting	SLRCKP	SBCKP	RLRCKP	RBCKP	0	OFSEL2	OFSEL1	OFSEL0
8	INT source selection	EMPF	SLIPO	PCRNW	UNPCM	CSRNW	FSCHG	INDET	ERROR
9	RERR condition setting	ERWT1	ERWT0	FSERR	RESTA	XTWT1	XTWT0	REDER	RESEL
10	Modulation system setting	P13	P12	P11	P10	0	VMODE	VISEL	UISEL
11	Modulation data setting	TCKSEL	0	TXMOD1	TXMOD0	TXMUT	TDTSEL	TWLRP	TXDFS
12	TEST	0	0	0	0	0	0	0	0
13	TEST	0	0	0	0	0	0	0	0
14	TEST	0	0	0	0	0	0	0	0
15	TEST	0	0	0	0	0	0	0	0

Table	123	Write	Register	Man
1 auto	14.5	<b>W</b> IIIC	Register	wiap

• The shaded parts of DI8 to DI15 in the command area are reserved bits. Input must be doing "0".

• Command addresses 0x12 to 0x15 are reserved for testing purposes. Writing to these addresses is prohibited.

### 12.2.2 Details of write commands

	CCB address: 0xE8; Command address: 0; All system settings										
	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DI0			
	0	0	0	0	0	0	CAU	CAL			
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8			
	TESTM	0	TXOPR	RXOPR	INTOPF	0	DOEN	SYSRST			
SYSRST		System reset 0: Don't reset (initial value) 1: Reset circuits other than command registers									
DOEN		DO pin output setting									
		0: Output (initial value)									
		1: Always high impedance state (read disabled)									
INTOPF		0: C		level durin	ng source o ng source o		(initial val	ue)			
RXOPR			perate (ini	nodulation itial value)							
TXOPR		Setting of modulation operation 0: Stop (initial value) 1: Operate									
TESTM	Test mode setting 0: Normal operation (initial value) 1: Enter test mode										

CCF	Andress.	$0 \mathbf{v} \mathbf{F} 8$	Command	address.	$0 \cdot 4$	All system	settings
	b audiess.	UALO.	Commanu	audiess.	U. F		seumes

• When reset by SYSRST is done or the demodulation is set to stop with RXOPR, RBCK and SBCK output "L", and RLRCK and SLRCK output "H".

	CCB add	ess: 0xE8;	Command	address:	1; Demodu	lation func	ction: Syste	em setting			
	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DI0	l		
	0	0	0	1	0	0	CAU	CAL	l		
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8	l		
	PBSEL1	PBSEL0	FSLIM1	FSLIM0	RXMON	AOSEL	VOSEL	UOSEL	I		
UOSEL		0: E		nphasis ou	ting (Wher tput (initial	n PBSEL1 l value)	is set to 0.)	)			
VOSEL		AUDIO/VO pin setting0: AUDIO channel status bit 1 output (initial value)1: VO validity flag output									
AOSEL		Output contents at the time of setting AUDIO is set with AUDIO/VO pin 0: only output channel status bit 1 (initial value) 1: output channel status bit 1, IEC61937 or DTS-CD/LD detection flag									
RXMON		0: D		or data inp		nonitoring initial valu	e)				
FSLIM [1:	0]	00: 01: 10:	ing of sam No limit (i fs ≤ 96kH2 fs ≤ 48kH2 Reserved	nitial valu z	•	ption range	e for input	digital data	ı signal		
PBSEL [1	:0]	00: 01: 10:	Preamble	out of swite B synchron	nization sig	gnal output	with PB, l	elock (initia DIT functio DIR functio	on		

• In case of setting with PBSEL at 1, terminal of EMPHA/UO/CO will be Channel status data output terminal CO and the setting for UOSEL is impossible. In case of setting with PBSEL at 0, the setting for EMPHA/UO/CO terminal follows the setting for UOSEL.

• The setting of AOSEL comes into effect in the case that the bit 1 output of channel status is selected with VOSEL. In the case that 1 is selected with AOSEL, AUDIO/VO terminal output high level, when either channel status bit 1 or IEC61937, non-PCM synchronous signal is detected.

CCB address: 0xE8; Command address: 2; Demodulation function: Master clock setting										
	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DIO		
	0	0	1	0	0	0	CAU	CAL		
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8		
	AMPOPR1	AMPOPR0	EXSYNC	PLLOPR	XMSEL1	XMSEL0	XINSEL	PLLSEL		
PLLSELPLL lock frequency setting $0: 512fs (fs \le 96kHz \text{ commend}) (initial value)$ $1: 256fs$ UDUSELWDUSEL										
XINSEL XIN input frequency setting 0: 12.288MHz (initial value) 1: 24.576MHz										
Х	MSEL [1:0]		XMCK output frequency setting 00: 1/1 of XIN input frequency (initial value) 01: 1/2 of XIN input frequency 10: Reserved 11: Muted							
P	LLOPR			operation se initial value)	0					
EXSYNCSetting of PLL unused demodulation (external synchronization)0: PLL used normal operation (initial value)1: PLL unused external synchronization operation (supply 256fs clock to TM										
А	MPOPR [1:0	)]	Oscillation amplifier operation setting 00: Automatic stopping of oscillation amplifier while PLL is locked (initial value 01: Permanent continuous operation 10: Reserved 11: Stop							

- If the PLL is stopped with PLLOPR while the PLL is locked, the output clocks are all muted and this muted status continues even if the PLL is unlocked.
- If the permanent continuous operation is set with AMPOPR[1:0] while the PLL is locked, RERR goes to into the error status once. It is possible to set the operation with maintaining the RERR status, if a setting with which even a changed fs is not regarded as an error due to the PLL status is made with FSERR.
- When an automatic stop mode of the oscillation amplifier is set with AMPOPR[1:0], and if the input fs changes within the PLL capture range and no lock error occurs, fs is not calculated with the oscillation amplifier stopped. For this reason, the input data fs and the fs calculation result may not be identical. However, if the channel status fs information is rewritten in line with input data changes, this information is reflected to the error flag and fs calculation of the input data is carried out. Since the fs calculation is always done when the oscillation amplifier is set to the permanent continuous operation mode, fs changes are always reflected to the error flag.

CCE	B address: 0	xE8; Comr	nand addre	ss: 3; Dem	odulation fu	unction: R s	system outp	out clock se	tting
	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DIO	
	0	0	1	1	0	0	CAU	CAL	
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8	
	XRLRCK1	XRLRCK0	XRBCK1	XRBCK0	XRSEL1	XRSEL0	PRSEL1	PRSEL0	
PRSEL	[1:0]	00 01 10	: 1/2 of PL : 1/1 of PL	LSEL settir LSEL settir		•			
XRSEL	[1:0]	00 01 10	: 1/1 of XII : 1/2 of XII	NSEL settir NSEL settir		•			
XRBCK	[1:0]	00 01 10	: 3.072MH : 6.144MH : 12.288MI	z output (in z output	frequency iitial value)	during XIN	source		
XRLRCK [1:0]       Setting of RLRCK output frequency during XIN source         00: 48kHz output (initial value)         01: 96kHz output         10: 192kHz output         11: Muted									

• If the RMCK frequency is set lower than RBCK when the XIN source is used, 3.072MHz is output from RBCK. This also applies to SBCK.

CCF	B address: 0	xE8: Com	nand addre	ss: 4: Dem	odulation f	unction: S s	system outr	out clock se	etting
0.01	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DIO	
	0	1	0	0	0	0	CAU	CAL	
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8	
	XSLRCK1	XSLRCK0	XSBCK1	XSBCK0	PSLRCK1	PSLRCK0	PSBCK1	PSBCK0	
PSBCK [1:0] Setting of SBCK frequency while PLL is locked 00: 64fs output (initial value) 01: 128fs output 10: 32fs output 11: Muted									
PSLRC	K [1:0]	00: 01: 10:	-	initial valu	•	PLL is locl	ked		
XSBCK	[1:0]	00: 01: 10:	-	z output (in z output	ncy during 2 aitial value)	XIN source	:		
XSLRCK [1:0] SLRCK output frequency setting during XIN source 00: 48kHz output (initial value) 01: 96kHz output 10: 192kHz output 11: Muted									

CCB addr	ess: 0xE8;	Command	address: 5	; Demodul	ation func	tion: Clock	source; R	DATA out	tput setting
CCB address: 0xE8; Command address: 5; Demodulation function: Clock source; RDATA output setting         Dif       Di6       Di6       Di4       Di3       Di2       Di1       Di0         0       1       0       1       0       0       CAU       CAU         Dif5       DI14       DI13       DI12       DI11       DI0       DI0       CAU         O       RDTMUT       RDTSTA       RDTSEL       0       RCKSEL       OCKSEL       SELMTD         SELMTD       Setting of output clock source switching method       0: Switch R system and S system simultaneously according to OCKSEL (initial value)         1: Switch R system according to RCKSEL and fix S system to XIN source         OCKSEL       Clock source setting when SELMTD = 0         0: Use XIN clock as source while PLL is unlocked (initial value)         1: Use XIN clock as source regardless of PLL status         RCKSEL       Clock source setting when SELMTD = 1         0: Use XIN clock as source regardless of PLL is unlocked         1: Use XIN clock as source regardless of PLL status         RDTSEL       RDATA output setting while PLL is unlocked         0: Output SDIN data while PLL is unlocked         0: According to RDTSEL (initial value)         1: Output SDIN input data regardless of PLL status         RDTMUT									
	0	1	0	1	0	0	CAU	CAL	
									_
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8	
	0	RDTMUT	RDTSTA	RDTSEL	0	RCKSEL	OCKSEL	SELMTD	
SELMTD		0: S	witch R sy	stem and S	S system s	imultaneou	sly accord	0	. ,
OCKSEL	0: Use XIN clock as source while PLL is unlocked (initial value)								
RCKSEL		0: U	Jse XIN cl	ock as sou	rce while F	PLL is unlo		al value)	
RDTSEL		0: C	output SDI	N data whi	ile PLL is			e)	
RDTSTA		0: A	According t	to RDTSE		,	status		
RDTMUT		0: C	ATA mute Jutput data Juted		vith RDTS	EL			

<sup>•</sup> When the oscillation amplifier is set to the permanent continuous operation mode with AMPOPR[1:0] or fs changes are set not to be reflected to the error flag with FSERR, OCKSEL and RCKSEL can switch the clock source while maintaining the RERR status. However, if none of these settings is made, RERR outputs an error once when switching occurs.

- To input data to SDIN, select a clock synchronized with the SDIN input data.
- The XIN source can be switched while maintaining the PLL locked status. However, since switching between clock and data output can be set independently, it is recommended to select mute or SDIN data for the output data when XIN source is switched.
- If the oscillation amplifier is set to stop automatically when the PLL gets locked, XIN source switching from the PLL locked status is executed after the oscillation is stabilized. Moreover, switching of output data at this time is subject to XIN source switching.

CCB ac	ddress: 0xE					<u> </u>		1 * *			
	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DIO			
	0	1	1	0	0	0	CAU	CAL			
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8			
	RXOFF	ROSEL2	ROSEL1	ROSEL0	ULSEL	RISEL2	RISEL1	RISELO			
NSEL [	[2:0]	00 00 01 01 10 10 11	0: RX0 seld 1: RX1 seld 0: RX2 seld 1: RX3 seld 0: RX4 seld 1: RX5 seld 0: RX6 seld	ection ection ection (How ection (How	al value) vever, VI ir vever, UI ir	nput is perfo	ormed when	n UISEL is			
JLSEL		0:	Setting of input pin via PLL unlock 0: Normal setting (initial value) 1: Setting of input data switching via PLL unlock								
ROSEL	[2:0]	RXOUT output data setting 000: RX0 input data (initial value) 001: RX1 input data 010: RX2 input data 011: RX3 input data 100: RX4 input data 101: RX5/VI input data 110: RX6/UI input data 111: Modulation function output (TXO output data) selection									
RXOFF		Setting of RXOUT output status 0: ROSEL[2:0] selection data output (initial value) 1: "L" fixed output									

• ULSEL can be set when the oscillation amplifier is set to the permanent continuous operation mode with AMPOPR[1:0]. ULSEL does not work correctly when the oscillation amplifier is stopped.

CCB	address; 0	xE8; Com	mand addr	ess: 7; Der	nodulation	function:	Output dat	ta format se	etting
	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DI0	U
	0	1	1	1	0	0	CAU	CAL	
					-	-	-		
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8	
	SLRCKP	SBCKP	RLRCKP	RBCKP	0	OFSEL2	OFSEL1	OFSEL0	
OFSEL [2:0]Audio data output format setting 000: I²S data output (initial value) 001: MSB-first left-justification data output 010: 24 bits MSB-first right-justification data output (master mode only) 011: 20 bits MSB-first right-justification data output (master mode only) 100: 16 bits MSB-first right-justification data output (master mode only) 101: Reserved 110: Reserved 111: Reserved									only)
RBCKP		0: F	CK output Calling RDA Rising RDA	ATA data o	change (ini	itial value)			
RLRCKP		0: "	*	L-channel	data; "H"	period: R-0 period: L-0		ta (initial v ta	alue)
SBCKPSBCK output polarity setting 0: Falling RDATA data change (initial value) 1: Rising RDATA data change									
SLRCKPSLRCK output polarity setting 0: "L" period: L-channel data; "H" period: R-channel data (initial value) 1: "L" period: R-channel data; "H" period: L-channel data									

• The data output format and RLRCK output polarity could be set independently. Set the RLRCH polarity in line with each data output format.

CCB	address: 0	xE8; Comr	nand addre	ess: 8; Den	nodulation	function: I	NT outpu	t contents setting			
	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DIO			
	1	0	0	0	0	0	CAU	CAL			
		•									
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8			
	EMPF	SLIPO	PCRNW	UNPCM	CSRNW	FSCHG	INDET	ERROR			
ERROR		0: E	Oon't outpu	output setti at (initial va RR pin stat	alue)						
INDET		Inp	ut data det	ection outp	out setting						
		-		t (initial va	-						
					status char	ige					
FSCHG	Setting of updated flag output of PLL lock frequency calculation result 0: Don't output (initial value) 1: Output updated flag of PLL lock frequency calculation result										
CSRNW		Out	put setting	for update	ed flag of f	irst 48-bit	channel st	atus data			
		0: E	Don't outpu	t (initial va	alue)						
		1: 0	Output upd	ate flag of	first 48-bit	channel st	tatus data				
UNPCM		0: I	Oon't outpu	t (initial va	-	on-PCM da e	ata detectio	on			
PCRNW		Out	nut settino	for undate	d flag of h	ourst pream	ble Pc				
1 010111				t (initial va							
					f burst prea	amble Pc					
SLIPO	Output setting of slip signal during slave operation 0: Don't output (initial value) 1: Output duplicate reading and a detection flag for missing of data output										
EMPF					sis detectio	on flag					
				t (initial va							
		1: 0	Output emp	hasis dete	ction flag						

• The channel status update flag compares the first 48 bits of data of the previous block with those of the current block. If these data are identical, it outputs a flag, considering the data has been updated.

• The burst preamble Pc update flag also compares the 16 bits of data of the previous block with those of the current data. If they are identical, an update flag is output.

CCB address	: 0xE8, Co	mmand ad	ldress: 9; I	Demodulati	ion functio	n: RERR o	output setting				
DI7	DI6	DI5	DI4	DI3	DI2	DI1	DIO				
1	0	0	1	0	0	CAU	CAL				
DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8				
ERWT1	ERWT0	FSERR	RESTA	XTWT1	XTWT0	REDER	RESEL				
RESEL											
REDER	Sett	ing of pari	tv error fla	ig output w	vithin 8 tim	es in a rov	v				
REDER	REDER Setting of parity error flag output within 8 times in a row 0: Output only when non-PCM data is recognized (initial value)										
		· ·		b-frame fo	-						
XTWT [1:0] RESTA	<ul> <li>Setting of clock switch wait time after PLL is unlocked</li> <li>O0: Clock switching after approx. 200µs from when oscillation amplifier starts (initial value)</li> <li>O1: Clock switching after approx. 100µs from when oscillation amplifier starts 10: Clock switching after approx. 50µs from when oscillation amplifier starts 11: Clock switching after PLL is unlocked</li> <li>RERR output condition setting</li> <li>O: Output PLL status all the time (Output PLL status even during XIN source)</li> </ul>										
			·	Set "H" to	RERR for	cibly)					
FSERR	<ul> <li>(initial status)</li> <li>1: Forcibly output error (Set "H" to RERR forcibly)</li> <li>Setting of error flag output condition according to fs change</li> <li>0: Reflect fs changes to error flag (initial value)</li> <li>1: Don't reflect fs changes to error flag</li> </ul>										
ERWT [1:0]	00: 01: 10:	Cancel err Cancel err Cancel err	or after pro or after pro or after pro	ne after PL eamble B i eamble B i eamble B i eamble B i	s counted 3 s counted 2 s counted 3	3 (initial va 24 12	ilue)				

- For Non-PCM data, the data defined with AOSEL is reflected. In other words, it is identical to the detected data output to AUDIO.
- Output data is muted if an error occurs due to non-PCM data with RESEL.
- The RESTA setting is not reflected to the output pins of data and clock.
- For FSERR, the fs calculation result obtained while the oscillation amplifier is stopped is not reflected. In this case, fs changes consist of only channel status fs information.
- ERWT[1:0] defines the interval of time for RERR to output error cancellation ("L") after PLL is locked. Since demodulated audio data is output after RERR cancels an error, you need to change this setting if the situation that the head of data is missing is a problem.

CCB address:	0xE8; Con	nmand add	ress: 10; N	Aodulation	function:	System set	ting, gener	al-purpose	I/O data input
	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DI0	-
	1	0	1	0	0	0	CAU	CAL	
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8	
	PI3	Pl2	PI1	PI0	0	VMODE	VISEL	UISEL	
UISEL		0: Iı				n data (init er data	ial value)		
VISEL		0: Iı				n data (init lidity flag	ial value)		
VMODE		0: V		nction V f tial value)	lag setting				
PIO		0: C		en general nitial value		O PIO0 ou	itput is set		
PI1		0: C	-	en general nitial value		O PIO1 ou	itput is set		
PI2		0: C		en general nitial value		O PIO2 ou	itput is set		
PI3		0: C	-	en general nitial value		O PIO3 ou	itput is set		

 $\bullet$  When you use general-purpose I/O PIO0 to PIO3 as output, set PIOEN to "L".

CCB ad	ldress: 0xE	8; Comma	nd address	: 11; Modu	ulation fun	ction: Digi	tal audio i	nput/output se	etting			
	DI7	DI6	DI5	DI4	DI3	DI2	DI1	DIO	-			
	1	0	1	1	0	0	CAU	CAL				
	DI15	DI14	DI13	DI12	DI11	DI10	DI9	DI8				
	TCKSEL	0	TXMOD1	TXMOD0	TXMUT	TDTSEL	TXLRP	TXDFS				
TXDFS	0: I <sup>2</sup> S data input (initial value) 1: MSB-first left-justification data input											
TXLRP	Setting of TLRCK input clock polarity 0: "L" period: L-channel data; "H" period: R-channel data (initial value) 1: "L" period: R-channel data; "H" period: L-channel data											
TDTSEL		Input data setting 0: TDATA input data (initial value) 1: SDIN input data										
TXMUT		TXO output setting 0: modulation data output (initial value) 1: "L" fixed output										
TXMOD [1:0]Mode setting 00: Normal operation (L-channel, R-channel stereo mode) (initial value 01: L-channel continuity (time-division mode) 10: R-channel continuity (time-division mode) 11: reserved								.e)				
TCKSEL		0:2	CK input o 56fs (initia 28fs	clock frequ al value)	ency settir	ng						

• In case of inputting 256fs clock into TMCK, the falling edge of TBCK should be in synchronized with the rising edge of TMCK. Also, in case of inputting 128fs clock into TMCK, the falling edge of TBCK is in synchronized with the falling of TMCK.

#### 12.2.3 Channel status data write

- For channel status data write with the modulation function, set the CCB address to 0xE9.
- DI0 to DI7 are not channel status bits. Be sure to input a chip address to DI0 and DI1. Input "0" to DI2, DI3, and DI7 because they are reserved by the system. Write length of the channel status data is determined with DI4 to DI6. This setting is possible up to 48 bits in units of 8 bits.
- After CE rises, input a clock combined DI0 to DI7 and write data length to CL clock to make CE "L". For example, if you write data up to the bit 15 by DI4 to DI6, CL must be 24 clocks while CE is rising. If this setting goes wrong, correct writing is not expected.
- Input data is written from preamble B where CE has become "L".

#### Table 12.3 Relation between Setting Register of Input Data Length and Data Length

DI	6	DI5	DI4	Feasible Data Range for Input			
0		0	0 0 Bit 0 to bit				
0		0	0 1 Bit 0 to bit 15				
0		1	0	Bit 0 to bit 23			
0		1	1	Bit 0 to bit 31			

DI6	DI5	DI4	Feasible Data Range for Input
1	0	0	Bit 0 to bit 39
1	0	1	Bit 0 to bit 47
1	1	0	Reserved
1	1	1	Reserved

	Table 12.4 Input Setting	g-Setting of Modulation	Function Channel Sta	tus Data- (CCB address : 0xE9)
--	--------------------------	-------------------------	----------------------	--------------------------------

Register	Bit No.	Description	Register	Bit No.	Description
D10	CAL	Lower chip address	DI28	Bit 20	Channel number
DI1	CAU	Higher chip address	DI29	Bit 21	
DI2	0	Reserved	DI30	Bit 22	
DI3	0		DI31	Bit 23	
DI4	0	Data length setting	DI32	Bit 24	Sampling frequency
DI5	0		DI33	Bit 25	
DI6	0		DI34	Bit 26	
DI7	0	Reserved	DI35	Bit 27	
DI8	Bit 0	Application	DI36	Bit 28	Clock accuracy
DI9	Bit 1	Control	DI37	Bit 29	
DI10	Bit 2		DI38	Bit 30	Not defined
DI11	Bit 3		DI39	Bit 31	
DI12	Bit 4		DI40	Bit 32	Word length
DI13	Bit 5		DI41	Bit 33	
DI14	Bit 6	Not defined	DI42	Bit 34	
DI15	Bit 7		DI43	Bit 35	
DI16	Bit 8	Category code	DI44	Bit 36	Not defined
DI17	Bit 9		DI45	Bit 37	
DI18	Bit 10		DI46	Bit 38	
DI19	Bit 11		DI47	Bit 39	
DI20	Bit 12		DI48	Bit 40	
DI21	Bit 13	]	DI49	Bit 41	]
DI22	Bit 14	]	DI50	Bit 42	]
DI23	Bit 15	]	DI51	Bit 43	]
DI24	Bit 16	Source number	DI52	Bit 44	]
DI25	Bit 17	<b>]</b>	DI53	Bit 45	]
DI26	Bit 18	]	DI54	Bit 46	]
DI27	Bit 19	7	DI55	Bit 47	

### 12.3 Read Data

### 12.3.1 List of read commands

- It is possible to read the following items.
- Monitor output of digital data input status
- Interrupt data output
- Output of general-purpose I/O input data
- Output of fs calculation result and fs counter data (8 bits)
- Output of first 48 bits of channel status
- Output of burst preamble Pc data

• CCB address 0xEB and output registers DO16 to DO23 are for testing.

Table 12.5 Read Register Map

Read Register Name	0xEA	0xEB	0xEC	0xED
DO0	RXDET0	PO0	CS bit 0	Pc bit 0
DO1	RXDET1	PO1	CS bit 1	Pc bit 1
DO2	RXDET2	PO2	CS bit 2	Pc bit 2
DO3	RXDET3	PO3	CS bit 3	Pc bit 3
DO4	RXDET4	FSC0	CS bit 4	Pc bit 4
DO5	RXDET5	FSC1	CS bit 5	Pc bit 5
DO6	RXDET6	FSC2	CS bit 6	Pc bit 6
DO7	RXDET7	FSC3	CS bit 7	Pc bit 7
DO8	OERROR	FSDAT0	CS bit 8	Pc bit 8
DO9	OINDET	FSDAT1	CS bit 9	Pc bit 9
DO10	OFSCHG	FSDAT2	CS bit 10	Pc bit 10
DO11	OCSRNW	FSDAT3	CS bit 11	Pc bit 11
DO12	OUNPCM	FSDAT4	CS bit 12	Pc bit 12
DO13	OPCRNW	FSDAT5	CS bit 13	Pc bit 13
DO14	OSLIPO	FSDAT6	CS bit 14	Pc bit 14
DO15	OEMPF	FSDAT7	CS bit 15	Pc bit 15
DO16	CSBITI	TEST0	CS bit 16	-
DO17	IEC1937	TEST1	CS bit 17	-
DO18	DTS51	TEST2	CS bit 18	-
DO19	DTSES	TEST3	CS bit 19	-
DO20	F0512	TSET4	CS bit 20	-
DO21	F1024	TEST5	CS bit 21	-
DO22	F2048	TEST6	CS bit 22	
DO23	F4096	TEST7	CS bit 23	-
DO24	_	-	CS bit 24	-
	_	-		-
DO46	-	-	CS bit 46	-
DO47	_	-	CS bit 47	-

		C	CB address:	0xEA, conte	ents of read	register outp	out	
	DO7	DO6	DO5	DO4	DO3	DO2	DO1	DO0
	RXDET7	RXDET6	RXDET5	RXDET4	RXDET3	RXDET2	RXDET1	RXDET0
RXE	DETO	(	RX0 input d ): No input d l: Input data	lata in RX0	0			
RXD	DET1	(	RX1 input d ): No input d l: Input data	lata in RX1	1			
RXD	DET2	(	RX2 input d ): No input d l: Input data	lata in RX2	2			
RXD	DET3	(	RX3 input d ): No input d l: Input data	lata in RX3	3			
RXD	DET4	(	RX4 input d ): No input d l: Input data	lata in RX4	4			
RXD	DET5	(	RX5 input d ): No input d l: Input data	lata in RX5	5			
RXD	DET6	(	RX6 input d ): No input d l: Input data	lata in RX6	6			
RXD	DET7	(	): No data ir	modulation	ation function function ou on function	tput TXO		

### 12.3.2 Read register 1 (input detection, interrupt flag, IEC61937 flag, DTS-CD flag)

• For readout of RXDET[7:0], RXMON must be set to "H" beforehand.

	CCB address; 0xEA; Contents of Read register output												
	DO15	DO14	DO13	DO12	DO11	DO10	DO9	DO8					
	OEMPF	OSLIPO	OPCRNW	OUNPCM	OCSRNW	OFSCHG	OINDET	OERROR					
OER	ROR		RERR outpu 0: No transfe 1: Transfer e	er error whil	e PLL is loc	ked							
OINI	DET		<ul> <li>Status change of data input pin (clear after readout)</li> <li>0: No change in status of data input pin</li> <li>1: Change exists in status of data input pin</li> <li>Result of updating input fs calculation (clear after readout)</li> </ul>										
OFS	CHG		Result of upo 0: No update 1: Input fs ca	e of input fs	calculation	n (clear afte	er readout)						
OCS	RNW		Update resul 0: Not updat 1: Updated		bits channel	status (clear	r after reado	ut)					
OUN	PCM		AUDIO outr 0: Non-PCM 1: Non-PCM	signal not o	detected	ng readout)							
OPC	RNW		Update resul 0: Not updat 1: Updated	-	eamble Pc (o	clear after re	adout)						
OSL	IPO		Detection of readout) 0: Not detect 1: duplicate	ted	-	-	during slave	operation (clear af					
OEM	IPF		Channel stat 0: No pre-en 1: 50/15µs p	nphasis		output of stat	tus during re	eadout)					

• Concerning OERROR and OUNPCM, the status of RERR and AUDIO that are subject to RESEL and AOSEL setting are read regardless of the INT output setting.

		CC	CB address:	0xEA; Cont	ents of read	register outp	out	
	DO23	DO22	DO21	DO20	DO19	DO18	DO17	DO16
	F4096	F2048	F1024	F0512	DTSES	DTS51	IEC1937	CSBIT1
CSB	IT1	(	Channel stat ): PCM l: Non-PCM	us bit 1 dete I	ction			
IEC1	1937	(	EC61937 b ): Pa, Pb not 1: Pa, Pb det		e detection			
DTS	51	(	): DTS-CD/	0 5.1 channe LD sync sig LD sync sig	nal not detec			
DTS	ES	(	): DTS ES-C	/LD 6.1 cha CD/LD sync CD/LD sync	signal not d	etected	on	
F051	2	(	): Sync sign	D IEC60958 al is not 512 al is 512 or 1	nor 1024 fr	ame interval		
F102	24	(	): Sync sign	0 IEC60958 al is not 102 al is 1024 or	4 nor 2048 f	rame interva	al	
F204	48	(	): Sync sign	0 IEC60958 al is not 204 al is 2048 or	8 nor 4096 f	rame interva	al	
F409	96	(	): Sync sign	0 IEC60958 al is not 409 al is 4096 fra	6 frame inte	rval		

	DO7	DO6	DO5	DO4	DO3	DO2	DO1	DO0			
	FSC3	FSC2	FSC1	FSC0	PO3	PO2	PO1	PO0			
PO0			Contents of 1 0: PIO0 inpu 1: PIO0 inpu	t = "L"	put when ge	eneral-purpo	se I/O PO0	input is set			
PO1			Contents of read data output when general-purpose I/O PIO1 input is set 0: PIO1 input = "L" 1: PIO1 input = "H"								
PO2			Contents of read data output when general-purpose I/O PIO2 input is set 0: PIO2 input = "L" 1: PIO2 input = "H"								
PO3			Contents of read data output when general-purpose I/O PIO3 input is set 0: PIO3 input = "L" 1: PIO3 input = "H"								
FSC [3:0	)]		Input data fs "xxxx": See		result						

12.3.3 Read register 2 (Contents of general-purpose I/O input, fs calculation result, fs counte	r data)

FSC3	FSC2	FSC1	FSC0	Target Frequency	Calculation Range (Design Value)
0	0	0	0	Out of range	_
0	0	0	1	-	_
0	0	1	0	-	_
0	0	1	1	-	_
0	1	0	0	16kHz	15.4k to 16.6kHz
0	1	0	1	22.05kHz	21.2k to 22.9kHz
0	1	1	0	24kHz	23.1k to 24.9kHz
0	1	1	1	32kHz	30.8k to 33.3kHz
1	0	0	0	44.1kHz	42.4k to 45.8kHz
1	0	0	1	48kHz	46.2k to 49.9kHz
1	0	1	0	64kHz	61.5k to 66.7kHz
1	0	1	1	88.2kHz	85.4k to 91.7kHz
1	1	0	0	96kHz	93.1k to 100.7kHz
1	1	0	1	128kHz	122.9k to 133.5kHz
1	1	1	0	176.4kHz	170.7k to 180.7kHz
1	1	1	1	192kHz	186.2k to 198.1kHz

CCB address: 0xEB; Contents of Read register output							
DO14	DO13	DO12	DO11	DO10	DO9		

DO15	DO14	DO13	DO12	DO11	DO10	DO9	DO8
FSDAT7	FSDAT6	FSDAT5	FSDAT4	FSDAT3	FSDAT2	FSDAT1	FSDAT0

FSDAT [7:0]

fs counter data output

- FSDAT [7:0] is the fs calculation counter value. The data length is 8 bits, FSDAT0 is LSB, and FSDAT7 is MSB.
- The relation between the count value and fs is expressed by the following equation.
  - fs = 6144/FSDAT (kHz)
- Since fs is calculated with 6.144MHz-clock, the calculation accuracy is subject to this clock.
- The calculation counter value is 8-bit output, so the fs capable of calculating is 24kHz or higher.

### 12.3.4 Read register 3 (readout of first 48 bits of channel status)

- The first 48 bits of channel status can be read with the demodulation function.
- The readout channel status data is output with LSB first.
- For readout, set the CCB address to 0xEC.
- The channel status data cannot be updated after the CCB address is set.
- The relation between the read registers and the channel status data is shown below.

Register	Bit No.	Contents
DO0	Bit 0	Application
DO1	Bit 1	Control
DO2	Bit 2	
DO3	Bit 3	
DO4	Bit 4	
DO5	Bit 5	
DO6	Bit 6	Not defined
DO7	Bit 7	
DO8	Bit 8	Category code
DO9	Bit 9	
DO10	Bit 10	
DO11	Bit 11	
DO12	Bit 12	
DO13	Bit 13	
DO14	Bit 14	
DO15	Bit 15	
DO16	Bit 16	Source number
DO17	Bit 17	
DO18	Bit 18	
DO19	Bit 19	
DO20	Bit 20	Channel number
DO21	Bit 21	
DO22	Bit 22	
DO23	Bit 23	

Contents	Register	Bit No.	Contents
Application	DO24	Bit 24	Sampling frequency
Control	DO25	Bit 25	
	DO26	Bit 26	
	DO27	Bit 27	
	DO28	Bit 28	Clock accuracy
	DO29	Bit 29	
Not defined	DO30	Bit 30	Not defined
	DO31	Bit 31	
Category code	DO32	Bit 32	Word length
	DO33	Bit 33	
	DO34	Bit 34	
	DO35	Bit 35	
	DO36	Bit 36	Not defined
	DO37	Bit 37	
	DO38	Bit 38	
	DO39	Bit 39	
Source number	DO40	Bit 40	
	DO41	Bit 41	
	DO42	Bit 42	
	DO43	Bit 43	
Channel number	DO44	Bit 44	
	DO45	Bit 45	
	DO46	Bit 46	
	DO47	Bit 47	

#### 12.3.5 Read register 4 (burst preamble Pc data)

- The burst preamble Pc data can be read with the demodulation function.
- The 16 bit-data of burst preamble Pc are output with LSB first.
- $\bullet$  For readout, set the CCB address to OxED.
- The relation between the read register and burst preamble Pc data is shown below.

Register	Bit No.	ble Pc Read Registers Contents
DO0	Bit 0	Data type
DO1	Bit 1	
DO2	Bit 2	
DO3	Bit 3	
DO4	Bit 4	
DO5	Bit 5	Reserved
DO6	Bit 6	
DO7	Bit 7	Error
DO8	Bit 8	Data type dependent
DO9	Bit 9	Information
DO10	Bit 10	
DO11	Bit 11	
DO12	Bit 12	
DO13	Bit 13	Bit stream number
DO14	Bit 14	
DO15	Bit 15	

# 12.4 Burst Preamble Pc Field

• The burst preamble Pc field is shown below.

• For the latest information, refer to official specifications.

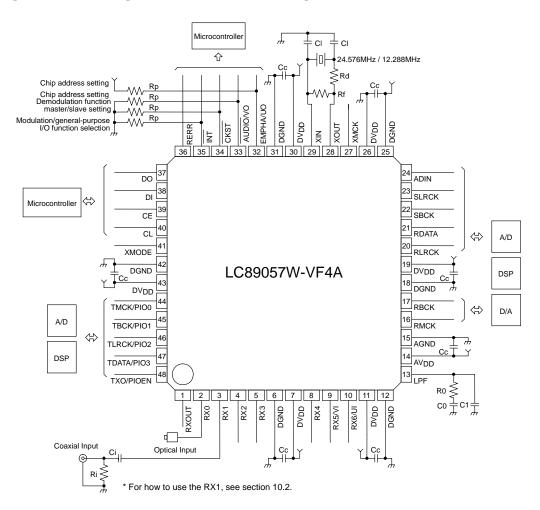
Register	Value	Contents		
DO4 to 0	0	NULL data		
	1	Dolby AC-3 data		
	2	Reserved		
	3	Pause		
	4	MPEG-1, layer 1 data		
	5	MPEG-1, layer 2, 3 data, or non-extended MPEG-2		
	6	Extended MPEG-2 data		
	7	Reserved		
	8	MPEG-2, layer 1, low sampling rate		
	9	MPEG-2, layer 2, 3, low sampling rate		
	10	Reserved		
	11	DTS type1		
	12	DTS type2		
	13	DTS type3		
	14	ATRAC		
	15	ATRACK2/3		
	16 to 26	Reserved		
	27	Reserved (MPEG-4, AAC data)		
	28	MPEG-2, AAC data		
	29 to 31	Reserved		
DO6, 5	0	Reserved (set to "0")		
DO7	0	Error flag indicating effective burst payload		
	1	Error flag indicating burst payload error		
DO12 to 8		Data type dependent information		
DO15 to 13	0	Bit stream number. (set to "0")		

#### Table 12.9 Burst Preamble Pc Field

### **13. Application Example**

#### **13.1 Basic Connection Diagram**

- Connect a de-coupling capacitance  $(0.1\mu F)$  as close as possible to the power supply pin. Use a ceramic capacitor with high-frequency characteristics for this capacitance.
- Use a capacitor with a low temperature coefficient for the PLL loop filter.



#### Table 13.1 Recommended Circuit Parameters (\*\*: See Section 10.1.1)

Element Symbol	Recommended Parameter	Application	Remarks
Cc	0.1µF	Power supply de-coupling	Ceramic capacitor
Rp	10kΩ	Function setting	Pull-down/pull-up resistor
C1	1pF to 33pF	Quarts resonator load	Ceramic capacitor with NP0 characteristics
Rf	1ΜΩ	Oscillation amplifier feedback	
Rd	220Ω	Oscillation amplifier current limit	
Ci	0.1µF	Coaxial input DC cut	Ceramic capacitor
Ri	75Ω	Coaxial input termination	
C0	**	PLL loop filter	
C1	**	PLL loop filter	
R0	**	PLL loop filter	

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